

NEXCOM International Co., Ltd.

Intelligent Digital Security Video Intelligent Surveillance NViS 5704 User Manual

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PREFACE

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Acknowledgements

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Regulatory Compliance Statements

This section provides the FCC compliance statement for Class B devices and describes how to keep the system CE compliant.

Declaration of Conformity

FCC

This equipment has been tested and verified to comply with the limits for a Class B digital device, pursuant to Part 15 of FCC Rules. These limits are designed to provide reasonable protection against harmful interference when the equipment is operated in a commercial environment. This equipment generates, uses, and can radiate radio frequency energy and, if not installed and used in accordance with the instructions, may cause harmful interference to radio communications. Operation of this equipment in a residential area (domestic environment) is likely to cause harmful interference, in which case the user will be required to correct the interference (take adequate measures) at their own expense.

CE

The product(s) described in this manual complies with all applicable European Union (CE) directives if it has a CE marking. For computer systems to remain CE compliant, only CE-compliant parts may be used. Maintaining CE compliance also requires proper cable and cabling techniques.



RoHS Compliance



NEXCOM RoHS Environmental Policy and Status Update

NEXCOM is a global citizen for building the digital infrastructure. We are committed to providing green products and services, which are compliant with

European Union RoHS (Restriction on Use of Hazardous Substance in Electronic Equipment) directive 2011/65/EU, to be your trusted green partner and to protect our environment.

RoHS restricts the use of Lead (Pb) < 0.1% or 1,000ppm, Mercury (Hg) < 0.1% or 1,000ppm, Cadmium (Cd) < 0.01% or 100ppm, Hexavalent Chromium (Cr6+) < 0.1% or 1,000ppm, Polybrominated biphenyls (PBB) < 0.1% or 1,000ppm, and Polybrominated diphenyl Ethers (PBDE) < 0.1% or 1,000ppm.

In order to meet the RoHS compliant directives, NEXCOM has established an engineering and manufacturing task force to implement the introduction of green products. The task force will ensure that we follow the standard NEXCOM development procedure and that all the new RoHS components and new manufacturing processes maintain the highest industry quality levels for which NEXCOM are renowned.

The model selection criteria will be based on market demand. Vendors and suppliers will ensure that all designed components will be RoHS compliant.

How to recognize NEXCOM RoHS Products?

For existing products where there are non-RoHS and RoHS versions, the suffix "(LF)" will be added to the compliant product name.

All new product models launched after January 2013 will be RoHS compliant. They will use the usual NEXCOM naming convention.



Warranty and RMA

NEXCOM Warranty Period

NEXCOM manufactures products that are new or equivalent to new in accordance with industry standard. NEXCOM warrants that products will be free from defect in material and workmanship for 2 years, beginning on the date of invoice by NEXCOM. HCP series products (Blade Server) which are manufactured by NEXCOM are covered by a three year warranty period.

NEXCOM Return Merchandise Authorization (RMA)

- Customers shall enclose the "NEXCOM RMA Service Form" with the returned packages.
- Customers must collect all the information about the problems encountered and note anything abnormal or, print out any on-screen messages, and describe the problems on the "NEXCOM RMA Service Form" for the RMA number apply process.
- Customers can send back the faulty products with or without accessories (manuals, cable, etc.) and any components from the card, such as CPU and RAM. If the components were suspected as part of the problems, please note clearly which components are included. Otherwise, NEXCOM is not responsible for the devices/parts.
- Customers are responsible for the safe packaging of defective products, making sure it is durable enough to be resistant against further damage and deterioration during transportation. In case of damages occurred during transportation, the repair is treated as "Out of Warranty."
- Any products returned by NEXCOM to other locations besides the customers' site will bear an extra charge and will be billed to the customer.

Repair Service Charges for Out-of-Warranty Products

NEXCOM will charge for out-of-warranty products in two categories, one is basic diagnostic fee and another is component (product) fee.

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System Level

- Component fee: NEXCOM will only charge for main components such as SMD chip, BGA chip, etc. Passive components will be repaired for free, ex: resistor, capacitor.
- Items will be replaced with NEXCOM products if the original one cannot be repaired. Ex: motherboard, power supply, etc.
- Replace with 3rd party products if needed.
- If RMA goods can not be repaired, NEXCOM will return it to the customer without any charge.

Board Level

- Component fee: NEXCOM will only charge for main components, such as SMD chip, BGA chip, etc. Passive components will be repaired for free, ex: resistors, capacitors.
- If RMA goods can not be repaired, NEXCOM will return it to the customer without any charge.

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Warnings

Read and adhere to all warnings, cautions, and notices in this guide and the documentation supplied with the chassis, power supply, and accessory modules. If the instructions for the chassis and power supply are inconsistent with these instructions or the instructions for accessory modules, contact the supplier to find out how you can ensure that your computer meets safety and regulatory requirements.

Cautions

Electrostatic discharge (ESD) can damage system components. Do the described procedures only at an ESD workstation. If no such station is available, you can provide some ESD protection by wearing an antistatic wrist strap and attaching it to a metal part of the computer chassis.



Safety Information

Before installing and using the device, note the following precautions:

- Read all instructions carefully.
- Do not place the unit on an unstable surface, cart, or stand.
- Follow all warnings and cautions in this manual.
- When replacing parts, ensure that your service technician uses parts specified by the manufacturer.
- Avoid using the system near water, in direct sunlight, or near a heating device.
- The load of the system unit does not solely rely for support from the rackmounts located on the sides. Firm support from the bottom is highly necessary in order to provide balance stability.
- The computer is provided with a battery-powered real-time clock circuit. There is a danger of explosion if battery is incorrectly replaced. Replace only with the same or equivalent type recommended by the manufacturer. Discard used batteries according to the manufacturer's instructions.

Installation Recommendations

Ensure you have a stable, clean working environment. Dust and dirt can get into components and cause a malfunction. Use containers to keep small components separated.

Adequate lighting and proper tools can prevent you from accidentally damaging the internal components. Most of the procedures that follow require only a few simple tools, including the following:

- A Philips screwdriver
- A flat-tipped screwdriver
- A grounding strap
- An anti-static pad

Using your fingers can disconnect most of the connections. It is recommended that you do not use needle-nose pliers to disconnect connections as these can damage the soft metal or plastic parts of the connectors.



Safety Precautions

- 1. Read these safety instructions carefully.
- 2. Keep this User Manual for later reference.
- 3. Disconnect this equipment from any AC outlet before cleaning. Use a damp cloth. Do not use liquid or spray detergents for cleaning.
- 4. For plug-in equipment, the power outlet socket must be located near the equipment and must be easily accessible.
- 5. Keep this equipment away from humidity.
- 6. Put this equipment on a stable surface during installation. Dropping it or letting it fall may cause damage.
- 7. The openings on the enclosure are for air convection to protect the equipment from overheating. DO NOT COVER THE OPENINGS.
- 8. Make sure the voltage of the power source is correct before connecting the equipment to the power outlet.
- 9. Place the power cord in a way so that people will not step on it. Do not place anything on top of the power cord. Use a power cord that has been approved for use with the product and that it matches the voltage and current marked on the product's electrical range label. The voltage and current rating of the cord must be greater than the voltage and current rating marked on the product.
- 10. All cautions and warnings on the equipment should be noted.
- 11. If the equipment is not used for a long time, disconnect it from the power source to avoid damage by transient overvoltage.
- 12. Never pour any liquid into an opening. This may cause fire or electrical shock.
- 13. Never open the equipment. For safety reasons, the equipment should be opened only by qualified service personnel.

- 14. If one of the following situations arises, get the equipment checked by service personnel:
 - a. The power cord or plug is damaged.
 - b. Liquid has penetrated into the equipment.
 - c. The equipment has been exposed to moisture.
 - d. The equipment does not work well, or you cannot get it to work according to the user's manual.
 - e. The equipment has been dropped and damaged.
 - f. The equipment has obvious signs of breakage.
- 15. Do not place heavy objects on the equipment.
- 16. The unit uses a three-wire ground cable which is equipped with a third pin to ground the unit and prevent electric shock. Do not defeat the purpose of this pin. If your outlet does not support this kind of plug, contact your electrician to replace your obsolete outlet.
- 17. CAUTION: DANGER OF EXPLOSION IF BATTERY IS INCORRECTLY REPLACED. REPLACE ONLY WITH THE SAME OR EQUIVALENT TYPE RECOMMENDED BY THE MANUFACTURER. DISCARD USED BATTERIES ACCORDING TO THE MANUFACTURER'S INSTRUCTIONS.

"ATTENTION: Risque d'explosion si la batterie est remplacée par un type incorrect. Mettre au rebus les batteries usagées selon les instructions."

18. This equipment is not suitable for use in locations where children are likely to be present.

Cet équipement ne convient pas à une utilisation dans des lieux pouvant accueillir des enfants.

19. Suitable for installation in Information Technology Rooms in accordance with Article 645 of the National Electrical Code and NFPA 75.

Peut être installé dans des salles de matériel de traitement de l'information conformément à l'article 645 du National Electrical Code et à la NFPA 75.



Technical Support and Assistance

- 1. For the most updated information of NEXCOM products, visit NEXCOM's website at www.nexcom.com.
- 2. For technical issues that require contacting our technical support team or sales representative, please have the following information ready before calling:
 - Product name and serial number
 - Detailed information of the peripheral devices
 - Detailed information of the installed software (operating system, version, application software, etc.)
 - A complete description of the problem
 - The exact wordings of the error messages

Warning!

- 1. Handling the unit: carry the unit with both hands and handle it with care.
- 2. Maintenance: to keep the unit clean, use only approved cleaning products or clean with a dry cloth.
- 3. CompactFlash: Turn off the unit's power before inserting or removing a CompactFlash storage card.
- 4. The ITE is to be connected only to PoE networks without routing to the outside plant.

Conventions Used in this Manual



Warning:

Information about certain situations, which if not observed, can cause personal injury. This will prevent injury to yourself when performing a task.



Caution:

Information to avoid damaging components or losing data.

Note:

Provides additional information to complete a task easily.



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Package Contents

Before continuing, verify that the NViS5704 package that you received is complete. Your package should have all the items listed in the following table.

No.	Item	Details
1	System	
2	CPU Cooler Box	Box
Z	CPU COOIEI DOX	CPU Cooler
		Вох
		Cable Tie
3	Accessories	PE Zipper Bag #3
	Terminal Block 10Pin	
		Flat Head Screw:F6#32Tx5mmNylok NIGP *8pcs
4	EPE Top*2pcs	
5	EPE Bottom*2pcs	

Ordering Information

The following information below provides ordering information for the NViS 5704.

NViS 5704 (P/N: 10C00570400X0)

1U rack workstation NVR



CHAPTER 1: PRODUCT INTRODUCTION

NViS 5704 Overview



Key Features

- System 1U rackmount
- 13th/12th Gen Intel[®] Core™
- 4-Bay 3.5" HDD (support RAID 0, 1, 5, 10)
- 1 x NVME SSD, 1 x M.2 2242 SATA SSD
- 1 x DisplayPort 1.4, 1 x HDMI 2.0b, 1 x HDMI 1.4
- DDR4 up to 64GB
- 2 x 2.5 GbE Intel[®] Ethernet
- Audio in/out/Mic
- PCIe Express x16



Hardware Specifications

CPU Support

• 13th/12th Gen Intel® Core™

Main Memory

- 2 x DDR4 SO-DIMM non-ECC support up to 64G
- Support OOB ECC in R680E

Platform Control Hub

Intel[®] Q670E (option R680E)

I/O Interface-Front

- 4 x Hot swappable 3.5" HDD bays
- 2 x USB 2.0 Type-A (per port output max 500mA)

I/O Interface-Rear

- 4 x USB 3.1 Gen1, Type-A (per port output Max 900mA)
- 1 x DisplayPort 1.4 (8K30)
- 1 x HDMI 2.0b (4K60)
- 1 x HDMI 1.4 (4K24)
- 1 x Audio port (Line in/ Line out/ MIC)
- 2 x RJ45 LAN (2 x 2.5Gps)
- 1 x GPIO 4in/2out (option)

Expansions

• 1 x PCIe Gen5 by 16 slot, support x16 lanes

Storage

- Hot swappable 3.5" HDD x 4
- M.2 2280 Key M support NVMe Gen4
- M.2 2242 Key B support SATA3

Power Input

• Single PSU 600W

Dimensions

• 479.4mm (W) x 44mm (H) x 560mm (D)

Environment

- Operating temperature:
- Ambient with air flow: 0°C ~ 40°C
- Storage temperature: -20°C ~ 70°C
- Relative humidity: 0% ~ 90% (non-condensing)

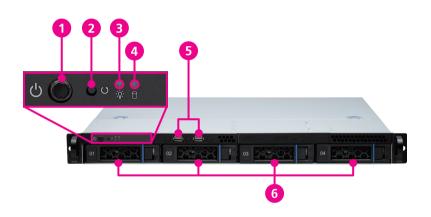
Certifications

- CE approval
- FCC Class A
- UL compliance



Knowing Your NViS 57xxx Series

Front Panel



1. Power Button

Press to power on/off the system.

2. Reset Pin Hole Reset the system by using a paper clip to push the pin hole.

3. Power LED Indicator

Lights up green when power is on.

4. Hard Disk Drive LED Indicator

Lights up green when the hard disk drives are activated.

5. Dual USB 2.0 Ports

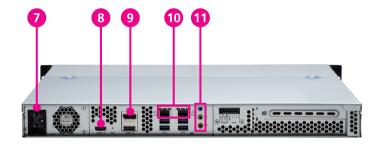
Used to connect USB 2.0 devices.

6. Swappable 3.5" HDD Bays

Used to connect 3.5" hard disk drives. The HDD LED indicator on the HDD tray is blue when powered on and turns green when activated.

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Rear Panel



- **7. ATX Power Connector** Used to plug the power cord.
- 8. HDMI 1.4b Connector

Connect to an HDMI 1.4b display.

9. DisplayPort 1.4 Connector

Connect to a DP1.4 displays.

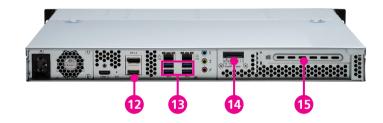
10. RJ45 LAN Ports

Connect the system to a local area network with speeds of up to 2.5Gbps.

11. Audio Jacks (Line in/Line out/MIC in)

Connect to audio equipment, these jacks include line-in (light blue), line-out (lime), and mic-in (pink).





12. HDMI 2.0a Connector

Connect to an HDMI 2.0a display.

13. USB 3.1 Gen1 Type-A Connectors

Used to connect USB 3.1 Gen 1 Type-A devices.

14. GPIO Terminal Block (Optional)

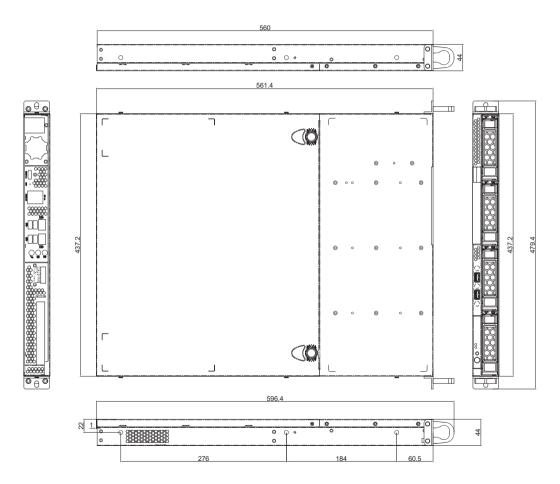
Connect to an external device with a maximum load of 24V, 1.0A.

15. PCIe Slot

Used to connect a PCIe expansion card, supporting x16 lanes (PCIe Gen 5: 1 x16)



Mechanical Dimensions





CHAPTER 2: JUMPERS AND CONNECTORS

This chapter describes how to set the jumpers and connectors on the NViS 5704 motherboard.

Before You Begin

- Ensure you have a stable, clean working environment. Dust and dirt can get into components and cause a malfunction. Use containers to keep small components separated.
- Adequate lighting and proper tools can prevent you from accidentally damaging the internal components. Most of the procedures that follow require only a few simple tools, including the following:
 - A Philips screwdriver
 - A flat-tipped screwdriver
 - A set of jewelers screwdrivers
 - A grounding strap
 - An anti-static pad
- Using your fingers can disconnect most of the connections. It is recommended that you do not use needle-nosed pliers to disconnect connections as these can damage the soft metal or plastic parts of the connectors.
- Before working on internal components, make sure that the power is off. Ground yourself before touching any internal components, by touching a metal object. Static electricity can damage many of the electronic components. Humid environments tend to have less static electricity than

dry environments. A grounding strap is warranted whenever danger of static electricity exists.

Precautions

Computer components and electronic circuit boards can be damaged by discharges of static electricity. Working on computers that are still connected to a power supply can be extremely dangerous.

Follow the guidelines below to avoid damage to your computer or yourself:

- Always disconnect the unit from the power outlet whenever you are working inside the case.
- If possible, wear a grounded wrist strap when you are working inside the computer case. Alternatively, discharge any static electricity by touching the bare metal chassis of the unit case, or the bare metal body of any other grounded appliance.
- Hold electronic circuit boards by the edges only. Do not touch the components on the board unless it is necessary to do so. Don't flex or stress the circuit board.
- Leave all components inside the static-proof packaging that they shipped with until they are ready for installation.
- Use correct screws and do not over tighten screws.

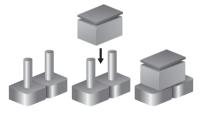


Jumper Settings

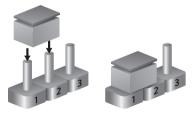
A jumper is the simplest kind of electric switch. It consists of two metal pins and a cap. When setting the jumpers, ensure that the jumper caps are placed on the correct pins. When the jumper cap is placed on both pins, the jumper is short. If you remove the jumper cap, or place the jumper cap on just one pin, the jumper is open.

Refer to the illustrations below for examples of what the 2-pin and 3-pin jumpers look like when they are short (on) and open (off).

Two-Pin Jumpers: Open (Left) and Short (Right)



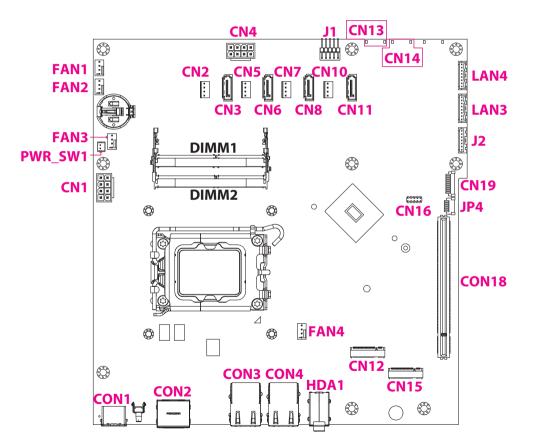
Three-Pin Jumpers: Pins 1 and 2 are Short





Locations of the NViS5704 Mainboard Jumpers and Connectors

The figure below shows the locations of the NViS5704 mainboard jumpers and connectors. Refer to the figure below for detailed information on pin settings and definitions marked in pink.





External I/O Interfaces HDMI 1.4b Connector

Connector location: CON1

19 18

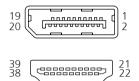
.

Pin	Definition	Pin	Definition
1	HDMI14_CM_DP2	3	HDMI14_CM_DN2
2	GND	4	HDMI14_CM_DP1
6	HDMI14_CM_DN1	5	GND
7	HDMI14_CM_DP0	9	HDMI14_CM_DN0
8	GND	10	HDMI14_CM_CKP
12	HDMI14_CM_CKN	11	GND
13	CEC	14	NC
15	HDMI14_SCL	16	HDMI14_SDA
17	GND	18	V5P0_HDMI0
19	HDMI14_HPD		



DisplayPort 1.4 and HDMI 2.0b Connectors

Connector location: CON2



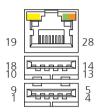
Pin	Definition	Pin	Definition
1	DP14_TX_CM_P0	2	GND1
3	DP14_TX_CM_N0	4	DP14_TX_CM_P1
5	GND2	6	DP14_TX_CM_N1
7	DP14_TX_CM_P2	8	GND3
9	DP14_TX_CM_N2	10	DP14_TX_CM_P3
11	GND4	12	DP14_TX_CM_N3
13	DP14_OB_AUX_EN	14	GND
15	DP14_AUXP_SNK	16	GND5
17	DP14_AUXN_SNK	18	DP14_HPD_SNK
19	GND	20	V3P3_DP14

Pin	Definition	Pin	Definition
21	HDMI20_CRLS_DP2	23	HDMI20_CRLS_DN2
22	GND	24	HDMI20_CRLS_DP1
26	HDMI20_CRLS_DN1	25	GND
27	HDMI20_CRLS_DP0	29	HDMI20_CRLS_DN0
28	GND	30	HDMI20_CRLS_CKP
32	HDMI20_CRLS_CKN	31	GND
33	CEC	34	NC
35	HDMI20_CRLS_SCL	36	HDMI20_CRLS_SDA
37	GND	38	V5P0_HDMI1
39	HDMI20_RT_HPD_SNK		



LAN1 Connector and USB 3.2 Ports

Connector type: RJ45 port with LEDs Dual USB3.1 Gen 1 Type A ports Connector location: CON3



.

Pin	Definition	Pin	Definition
1	V5P0_USB3_P12	2	USB2_1_DN_CM
3	USB2_1_DP_CM	4	GND9
5	USB31_1_RXN_CM	6	USB31_1_RXP_CM
7	GND11	8	USB31_1_TXN_CM
9	USB31_1_TXP_CM	10	V5P0_USB3_P12
11	USB2_2_DN_CM	12	USB2_2_DP_CM
13	GND10	14	USB31_2_RXN_CM
15	USB31_2_RXP_CM	16	GND12
17	USB31_2_TXN_CM	18	USB31_2_TXP_CM
19	GND	20	LAN1_PHY_PO
21	LAN1_PHY_N0	22	LAN1_PHY_P1
23	LAN1_PHY_N1	24	LAN1_PHY_P2
25	LAN1_PHY_N2	26	LAN1_PHY_P3
27	LAN1_PHY_N3	28	GND13
29	V3P3A_LAN1	30	LAN1_PHY_LED_ACT_N_R
31	LAN1_PHY_LED_1000_N_R	32	LAN1_PHY_LED_2500_N_R

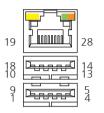
Act	Status
Blinking Yellow	Data activity
Off	No activity

Link	Status
Steady Green	2.5Gbp/s network link
Steady Orange	1Gbp/s network link
Off	100Mbps or no link



LAN2 Connector and USB 3.2 Ports

Connector type: RJ45 port with LEDs Dual USB3.1 Gen 1 Type A ports Connector location: CON4



.

Pin	Definition	Pin	Definition
1	V5P0_USB3_P34	2	USB2_3_DN_CM
3	USB2_3_DP_CM	4	GND9
5	USB31_3_RXN_CM	6	USB31_3_RXP_CM
7	GND11	8	USB31_3_TXN_CM
9	USB31_3_TXP_CM	10	V5P0_USB3_P34
11	USB2_4_DN_CM	12	USB2_4_DP_CM
13	GND10	14	USB31_4_RXN_CM
15	USB31_4_RXP_CM	16	GND12
17	USB31_4_TXN_CM	18	USB31_4_TXP_CM
19	GND	20	LAN2_PHY_P0
21	LAN2_PHY_N0	22	LAN2_PHY_P1
23	LAN2_PHY_N1	24	LAN2_PHY_P2
25	LAN2_PHY_N2	26	LAN2_PHY_P3
27	LAN2_PHY_N3	28	GND13
29	V3P3A_LAN2	30	LAN2_PHY_LED_ACT_N_R
31	LAN2_PHY_LED_1000_N_R	32	LAN2_PHY_LED_2500_N_R

Act	Status
Blinking Yellow	Data activity
Off	No activity

Link	Status	
Blinking Green	2.5Gbp/s network link	
Blinking Orange	1Gbp/s network link	
Off	100Mbps or no link	



Audio Jacks

.

Connector type: Line In, Line Out, MIC Connector location: HDA1

0	Line In
0	Line Out
0	MIC

USB 2.0 Ports

Connector type: USB 2.0 Type A ports Connector location: J1



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Pin	Definition	Pin	Definition
1	AGND_P	2	MIC_OUT_L_C
3	AGND_P	4	MIC1_JD
5	MIC_OUT_R_C		
22	LINE_OUT_L_C	23	AGND_G
24	FRONT_JD	25	LINE_OUT_R_C
32	LINE-L_C	33	AGND_B
34	LINEIN1_JD	35	LINE-R_C

Pin	Definition	Pin	Definition
1	V5P0_USB2_HDR	2	V5P0_USB2_HDR
3	USB2_5_DN_CM	4	USB2_6_DN_CM
5	USB2_5_DP_CM	6	USB2_6_DP_CM
7	GND	8	GND
9	Х	10	N/C



Internal I/O Interfaces **12V Power In Connector**

Connector location: CN1



SATA Power Connectors

Connector location: CN2, CN5, CN7, CN10



.

Pin	Definition	Pin	Definition
1	GND1	2	GND2
3	GND3	4	GND4
5	V12P0A_2_1	6	V12P0A_2_2
7	V12P0A_2_3	8	V12P0A_2_4

CN2

. . . .

Pin	Definition	Pin	Definition
1	V12P0_HDD0	2	GND
3	GND	4	V5P0_HDD0

CN5

Pin	Definition	Pin	Definition
1	V12P0_HDD1	2	GND
3	GND	4	V5P0_HDD1

CN7

Pin	Definition	Pin	Definition
1	V12P0_HDD2	2	GND
3	GND	4	V5P0_HDD2

CN10

Pin	Definition	Pin	Definition
1	V12P0_HDD3	2	GND
3	GND	4	V5P0_HDD3



RAID SATA Connectors

Connector location: CN3, CN6, CN8, CN11

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CN3 (Port0)

Pin	Definition	Pin	Definition
1	GND1	2	RSATA_CON0_TXP
3	RSATA_CON0_TXN	4	GND2
5	RSATA_CON0_RXN	6	RSATA_CON0_RXP
7	GND3		

CN6 (Port1)

Pin	Definition	Pin	Definition
1	GND1	2	RSATA_CON1_TXP
3	RSATA_CON1_TXN	4	GND2
5	RSATA_CON1_RXN	6	RSATA_CON1_RXP
7	GND3		

CN8 (Port2)

Pin	Definition	Pin	Definition
1	GND1	2	RSATA_CON2_TXP
3	RSATA_CON2_TXN	4	GND2
5	RSATA_CON2_RXN	6	RSATA_CON2_RXP
7	GND3		

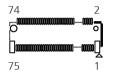
CN11 (Port3)

Pin	Definition	Pin	Definition
1	GND1	2	RSATA_CON3_TXP
3	RSATA_CON3_TXN	4	GND2
5	RSATA_CON3_RXN	6	RSATA_CON3_RXP
7	GND3		



M.2 Key B Slot

Connector type: M.2 Key B 2280 slot (SATA/USB3.0) Connector location: CN12



Pin	Definition	Pin	Definition
1	M2B_CONFIG_3	2	V3P3_M2B_1
3	GND1	4	V3P3_M2B_2
5	GND2	6	M2B_SSD_FULL_PWR_OFF_N
7	M2B_USB2_DP	8	M2B_PLN_N
9	M2B_USB2_DN	10	M2B_SATA_LED_N
11	GND3	20	GPIO_5/RFU_1.8V
21	M2B_CONFIG_0	22	GPIO_6/RFU_1.8V
23	WAKE_ON_WWA#_1.8V	24	GPIO_7/RFU_1.8V
25	DPR_1.8V	26	W_DISABLE2#_1.8V
27	GND4	28	GPIO_8/RFU_1.8V
29	M2B_PER1N	30	UIM-RESET
31	M2B_PER1P	32	UIM-CLK
33	GND5	34	UIM-DATA
35	M2B_PET1N	36	UIM-PWR
37	M2B_PET1P	38	DEVSLP
39	GND6	40	GPIO_0
41	M2B_PEROP	42	GPIO_1

Pin	Definition	Pin	Definition
43	M2B_PERON	44	GPIO_2
45	GND7	46	GPIO_3
47	M2B_PETON	48	GPIO_4
49	M2B_PETOP	50	M2B_PCI_RST_N
51	GND8	52	CLKREQ#
53	REFCLKn	54	PCIE_WAKE#
55	REFCLKp	56	M2B_SMDAT
57	GND9	58	M2B_SMCLK
59	ANTCTL0_1.8V	60	COEX3_1.8V
61	ANTCTL1_1.8V	62	COEX_TXD_1.8V
63	ANTCTL2_1.8V	64	COEX_RXD_1.8V
65	ANTCTL3_1.8V	66	SIM_DETECT
67	LTE_RST#_1.8V	68	M2B_SUSCLK
67	M2B_CONFIG_1	70	V3P3_M2B_3
71	GND10	72	V3P3_M2B_4
73	GND11	74	V3P3_M2B_5
75	M2B_CONFIG_2		



Front Panel Connector

Connector type: Wire to BD connector Connector location: CN13

DB9 Output

Connector type: Wire to BD connector Connector location: CN14



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Pin	Definition	Pin	Definition
1	V3P3A	2	V3P3_DSW
3	GND	4	RSTBTN_N
5	PWRBTN_N_S2	6	GND
7	LED_HDD_PU	8	LED_HDD_LOGIC_N
9	LED_PWR_PU	10	LED_PWR_LOGIC_N

Pin	Definition	Pin	Definition
1	GND	2	HDR_RI_N
3	HDR_CTS_N	4	HDR_RTS_N
5	HDR_DSR_N	6	GND
7	HDR_DTR_N	8	HDR_TXD
9	HDR_RXD	10	HDR_DCD_N



M.2 Key M Slot

.

Connector type: M.2 Key M 2280 slot (PCIe Gen4 x4) Connector location: CN15



Pin	Definition	Pin	Definition
1	GND1	2	V3P3A_M2M_1
3	GND2	4	V3P3A_M2M_2
5	NVME_RXN3	6	M2M_FULL_PWROFF_N
7	NVME_RXP3	8	M2M_PLN_N
9	GND3	10	M2M_LED_OC
11	NVME_TXN3	12	V3P3A_M2M_6
13	NVME_TXP3	14	V3P3A_M2M_7
15	GND4	16	V3P3A_M2M_8
17	NVME_RXN2	18	V3P3A_M2M_9
19	NVME_RXP2	20	NC2
21	GND5	22	NC3
23	NVME_TXN2	24	NC4
25	NVME_TXP2	26	NC5
27	GND6	28	NC6
29	NVME_RXN1	30	NC7
31	NVME_RXP1	32	NC8
33	GND7	34	NC9

Pin	Definition	Pin	Definition
35	NVME_TXN1	36	NC10
37	NVME_TXP1	38	M2M_DEVSLP
39	GND8	40	M2M_SMBCLK_V1P8
41	NVME_RXN0	42	M2M_SMBDAT_V1P8
43	NVME_RXP0	44	M2M_ALERT_N_V1P8
45	GND9	46	NC14
47	NVME_TXN0	48	NC15
49	NVME_TXP0	50	M2M_PERST_N
51	GND10	52	M2M_NVME_PCH_CLKREQ_N
53	NVME_CLKN	54	M2M_WAKE_N
55	NVME_CLKP	56	NC16
57	GND11	58	NC17
67	NC26	68	M2M_SUSCLK
69	M2M_SSD_DETECT	70	V3P3A_M2M_3
71	GND12	72	V3P3A_M2M_4
73	GND13	74	V3P3A_M2M_5
75	M2M_Mount_Detect		

NE;COM



GPIO Connector

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Connector location: CN16

Debug Connector

Connector type: Wire to BD connector Connector location: CN19



Pin	Definition	Pin	Definition
1	V5P0_4I4O	2	GND
3	PIO_IN_80	4	PIO_OUT_84
5	PIO_IN_81	6	PIO_OUT_85
7	PIO_IN_82	8	PIO_OUT_86
9	PIO_IN_83	10	PIO_OUT_87

Pin	Definition	Pin	Definition
1	V3P3A	2	DBG_ESPI_RSTO_N
3	DBG_ESPI_IO0	4	DBG_ESPI_IO1
5	DBG_ESPI_IO2	6	DBG_ESPI_IO3
7	DBG_ESPI_CSO_N	8	DBG_ESPI_CLK
9	DBG_PLTRST_N	10	GND



PCIe Slot

Connector type: PCle Gen 5 x16 Connector location: CON18

A1	A82
B1	B82

Pin	Definition	Pin	Definition
A1	GND	A2	V12P0_SLOT_1
A3	V12P0_SLOT_2	A4	GND_1
A5	TCK	A6	TDI
A7	TDO	A8	TMS
A9	V3P3S_SLOT_1	A10	V3P3S_SLOT_2
A11	PEG_RST_N	A12	GND_2
A13	PEG_SLOT_CLKP	A14	PEG_SLOT_CLKN
A15	GND_3	A16	CPU_PEG_RXP0
A17	CPU_PEG_RXN0	A18	GND_4
A19	PEG_PWR_EN	A20	GND_5
A21	CPU_PEG_RXP1	A22	CPU_PEG_RXN1

Pin	Definition	Pin	Definition
A23	GND_6	A24	GND_7
A25	CPU_PEG_RXP2	A26	CPU_PEG_RXN2
A27	GND_8	A28	GND_9
A29	CPU_PEG_RXP3	A30	CPU_PEG_RXN3
A31	GND_10	A32	PEG_PWR_OK
A33	RSVD3	A34	GND_11
A35	CPU_PEG_RXP4	A36	CPU_PEG_RXN4
A37	GND_12	A38	GND_13
A39	CPU_PEG_RXP5	A40	CPU_PEG_RXN5
A41	GND_14	A42	GND_15

Continued on the next page



Pin	Definition	Pin	Definition
A43	CPU_PEG_RXP6	A44	CPU_PEG_RXN6
A45	GND_16	A46	GND_17
A47	CPU_PEG_RXP7	A48	CPU_PEG_RXN7
A49	GND_18	A50	RSVD4
A51	GND_19	A52	CPU_PEG_RXP8
A53	CPU_PEG_RXN8	A54	GND_20
A55	GND_21	A56	CPU_PEG_RXP9
A57	CPU_PEG_RXN9	A58	GND_22
A59	GMD_23	A60	CPU_PEG_RXP10
A61	CPU_PEG_RXN10	A62	_GND_24

Pin	Definition	Pin	Definition
A63	GND_25	A64	CPU_PEG_RXP11
A65	CPU_PEG_RXN11	A66	GND_26
A67	GND_27	A68	CPU_PEG_RXP12
A69	CPU_PEG_RXN12	A70	GND_28
A71	GND_29	A72	CPU_PEG_RXP13
A73	CPU_PEG_RXN13	A74	GND_30
A75	GND_31	A76	CPU_PEG_RXP14
A77	CPU_PEG_RXN14	A78	GND_32
A79	GND_33	A80	CPU_PEG_RXP15
A81	CPU_PEG_RXN15	A82	GND_34
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Pin	Definition	Pin	Definition
B1	V12P0_SLOT_3	B2	V12P0_SLOT_4
B3	V12P0_SLOT	B4	GND_35
B5	SLOT1_SMCLK	B6	SLOT1_SMSDA
B7	GND_36	B8	V3P3S_SLOT_3
B9	TRST#	B10	V3P3A_SLOT
B11	PEG_WAKE_N	B12	PEG_B12
B13	GND_37	B14	PEG_TXP0
B15	PEG_TXN0	B16	GND_38
B17	PEG_PRSNT2_N	B18	GND_39
B19	PEG_TXP1	B20	PEG_TXN1
B21	GND_40	B22	GND_41

Pin	Definition	Pin	Definition
B23	PEG_TXP2	B24	PEG_TXN2
B25	GND_42	B26	GND_43
B27	PEG_TXP3	B28	PEG_TXN3
B29	GND_44	B30	PEG_SEL_N
B31	PEG_PRSNT2_N	B32	GND_45
B33	PEG_TXP4	B34	PEG_TXN4
B35	GND_46	B36	GND_47
B37	PEG_TXP5	B38	PEG_TXN5
B39	GND_48	B40	GND_49
B41	PEG_TXP6	B42	PEG_TXN6
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Pin	Definition	Pin	Definition
B43	GND_50	B44	GND_51
B45	PEG_TXP7	B46	PEG_TXN7
B47	GND_52	B48	PEG_PRSNT2_N
B49	GND_53	B50	PEG_TXP8
B51	PEG_TXN8	B52	GND_54
B53	GND_55	B54	PEG_TXP9
B55	PEG_TXN9	B56	GND_56
B57	GND_57	B58	PEG_TXP10
B59	PEG_TXN10	B60	GND_58
B61	GND_59	B62	PEG_TXP11

Pin	Definition	Pin	Definition
B63	PEG_TXN11	B64	GND_60
B65	GND_61	B66	PEG_TXP12
B67	PEG_TXN12	B68	GND_62
B69	GND_63	B70	PEG_TXP13
B71	PEG_TXN13	B72	GND_64
B73	GND_65	B74	PEG_TXP14
B75	PEG_TXN14	B76	GND_66
B77	GND_67	B78	PEG_TXP15
B79	PEG_TXN15	B80	GND_68
B81	PEG_PRSNT2_2nd_Slot_N	B82	PEG_SEL_X8_X16

NECOM

Fan Connectors

Connector location: FAN1, FAN2, FAN3, FAN4



FAN1

Pin	Definition	Pin	Definition
1	GND	2	V12P0_FANG1
3	SYS2_FAN_TACO	4	SYS2_FAN_PWM

FAN2

Pin	Definition	Pin	Definition
1	GND	2	V12P0_FANG1
3	SYS1_FAN_TACO	4	SYS1_FAN_PWM

FAN3

Pin	Definition	Pin	Definition
1	GND	2	V12P0S
3	CPU_FAN_TACO	4	CPU_FAN_PWM

FAN4

Pin	Definition	Pin	Definition
1	GND	2	V12P0_FANG2
3	sys3_fan_taco	4	SYS3_FAN_PWM



POE Connector

Connector type: Wire to BD connector Connector location: J2

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PWR_SW Connector

Connector type: Wire to BD connector Connector location: PWR_SW1

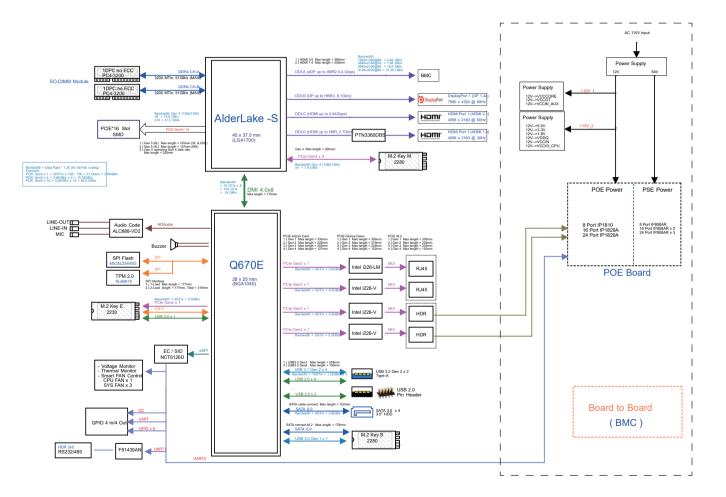
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Pin	Definition	Pin	Definition
1	V12POE	2	V12POE
3	POE_RXD_IN	4	POE_TXD_OUT
5	POE_RST_OUT	6	GND
7	GND	8	

Pin	Definition	Pin	Definition
1	GND	2	PWRBTN_N



Block Diagram





CHAPTER 3: SYSTEM SETUP

Removing the Chassis Cover



Prior to removing the chassis cover, make sure the unit's power is off and disconnected from the power sources to prevent electric shock or system damage.

- 1. Unscrew the F#6-32 screws on both side panels (refer to the images below for their locations).
- 2. Press the buttons indicated below, then slide the top cover outward and lift it up to fully open the chassis.









3. Once the top cover is removed, it will look like the image below.





Installing SO-DIMM DDR4 Memory Modules

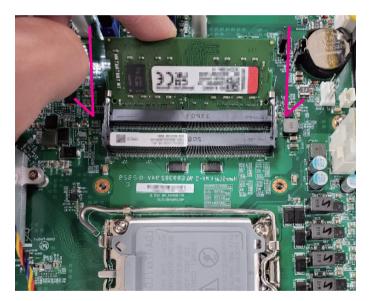
1. Locate the SO-DIMM sockets on the mainboard.





- 1. There is no specific installation order when inserting the memory module. Users can install the memory in either DIMM 1 or DIMM 2 according to their requirements.
- 2. Note that the memory sockets are designed with fool-proof measures. Do not force-plug the memory module(s) if they are not oriented correctly.

2. Insert the memory module into the socket at an approximately 30 degrees angle. The ejector tabs at the ends of the socket will automatically snap into the locked position to hold the module in place. Repeatedly follow the step above to insert the second memory module if required.



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3. The assembly steps are completed.





Installing a CPU

1. Locate the CPU sockets on the mainboard.



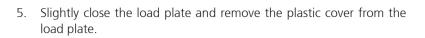
2. Release the load lever by pushing it down from the retention tab, then pull it up.



3. Lift the CPU load plate up to open the socket completely.



4. Insert the CPU into the CPU load bracket, ensuring that you align the triangle and notches on the CPU with the corresponding triangle marker and notches on the CPU load bracket.





6. Gently push the load lever down until it locks under the retention tab.











Installing a CPU Cooler

1. Refer to the previous section for CPU installation, and make sure the CPU is installed properly.



2. Retrieve the CPU cooler from the accessory box. To maintain optimal heat dissipation effectiveness, avoid touching the thermal paste located at the bottom of the cooler.







3. Ensure proper airflow direction by orienting the exhaust side towards the I/O panel of the system, and follow the sequence marked below the image.

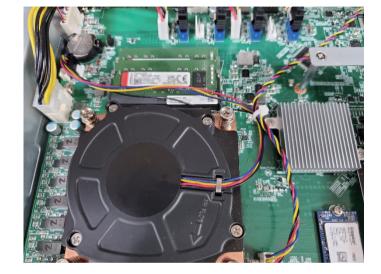


4. Plug the cooler power into the FAN3 on the mainboard (ensure the pins are fully and properly plugged).

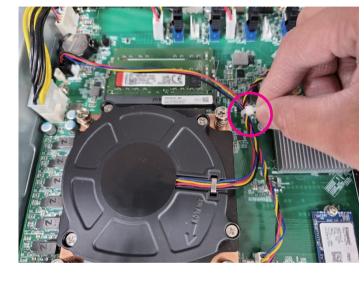


5. Use the provided cable ties to bundle the cooler power cable together with the system fan power cables, then trim off the excess.





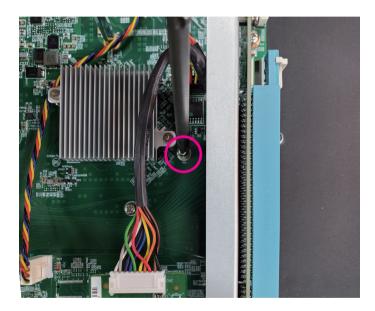




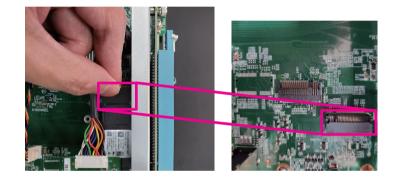


Installing an M.2 Module (Key M 2280)

1. Loosen the screw on the mainboard and set it aside for later use.



2. Insert the M.2 module into the M.2 Key M slot at a 45-degree angle until the gold-plated connector on the edge of the module completely disappears into the slot.





3. Push the M.2 module down and secure it with the screw that was removed from step 1.



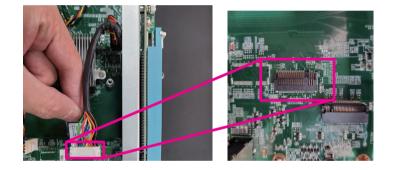


Installing an M.2 Module (Key M 2242)

1. Loosen the screw on the mainboard and set it aside for later use.

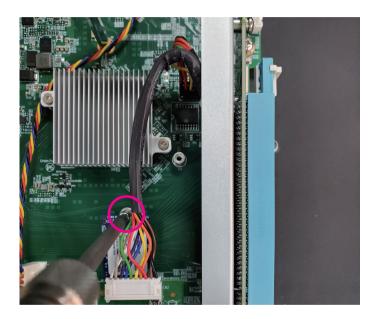


2. Insert the M.2 module into the M.2 Key M slot at a 45-degree angle until the gold-plated connector on the edge of the module completely disappears into the slot.





3. Push the M.2 module down and secure it with the screw that was removed from step 1.





Installing 3.5" HDD Device(s)

- 1. Press the release button (A) next to the HDD bay tray to withdraw the HDD tray (B).
- Insert an HDD following the orientation shown below into the HDD tray (C), then push the HDD forward until it clicks into place (D).









- 3. Secure the HDD using F#6-32 screws with a clockwise orientation on both sides of the HDD tray.
- 4. Insert the HDD tray with the installed HDD back into the HDD bay of the system, repeating the steps to install additional HDDs if needed.









Removing 3.5" HDD Device(s)

1. Loosen the F#6-32 screws on both sides of the panels using a screwdriver with a counterclockwise orientation.



2. Push the latch upward until it reaches 90 degrees using your fingers.





3. Push the 3.5" HDD forward (A), then lift it upwards with your fingers to remove it (B).

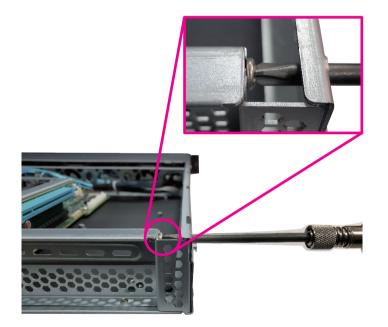


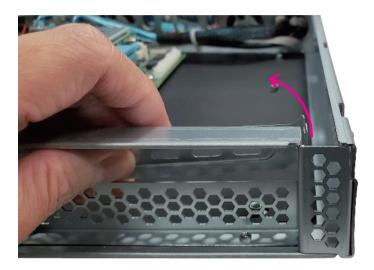
44



Installing an Add-On Card

1. Loosen the screw on the mainboard and set it aside for later use. 2. Remove the PCIe Bracket.





- 3. Carefully align the golden contacts on the graphics card with the PCIe slot and gently push it in until it securely clicks into place.
- 4. Reattach the PCIe bracket onto the chassis, then use the screw you set aside in step 1 to firmly secure both the bracket and the graphics card in place.









Reassembling the Chassis

1. Install the top cover back to its original position.



2. Secure the screws back to their original positions.





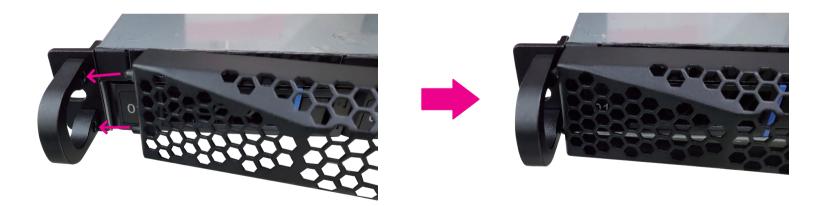


Installing the Front Bezel

1. To install the front bezel, align the two tabs on the left side of the front bezel with the mounting holes on the chassis ear of the system. Refer to the location of the mounting holes shown in the image below.

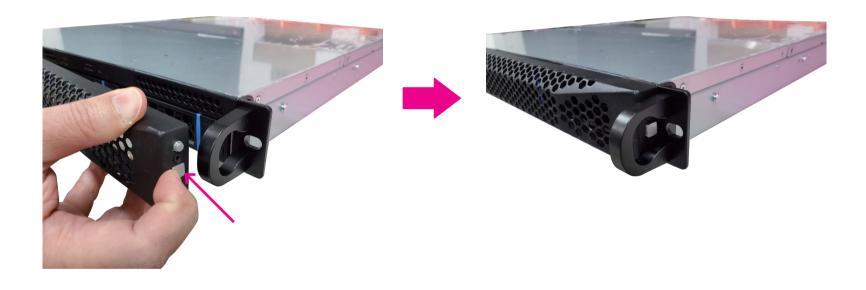


Front Bezel





2. Once the installation on the left side is complete, press down the latch of the front bezel on the right side as indicated below, then align and snap it into place in the mounting hole of the chassis ear.





3. The installation is complete.



4. To pull out the front bezel, press to release the latch on the right side.





CHAPTER 4: BIOS SETUP

This chapter describes how to use the BIOS setup program for the NViS 5704. The BIOS screens provided in this chapter are for reference only and may change if the BIOS is updated in the future.

To check for the latest updates and revisions, visit the NEXCOM website at www.nexcom.com.tw.

About BIOS Setup

The BIOS (Basic Input and Output System) Setup program is a menu driven utility that enables you to make changes to the system configuration and tailor your system to suit your individual work needs. It is a ROM-based configuration utility that displays the system's configuration status and provides you with a tool to set system parameters.

These parameters are stored in non-volatile battery-backed-up CMOS RAM that saves this information even when the power is turned off. When the system is turned back on, the system is configured with the values found in CMOS.

With easy-to-use pull down menus, you can configure such items as:

- Hard drives, diskette drives, and peripherals
- Video display type and display options
- Password protection from unauthorized use
- Power management features

The settings made in the setup program affect how the computer performs. It is important, therefore, first to try to understand all the setup options, and second, to make settings appropriate for the way you use the computer.

When to Configure the BIOS

- This program should be executed under the following conditions:
- When changing the system configuration
- When a configuration error is detected by the system and you are prompted to make changes to the setup program
- When resetting the system clock
- When redefining the communication ports to prevent any conflicts
- When making changes to the Power Management configuration
- When changing the password or making other changes to the security setup

Normally, CMOS setup is needed when the system hardware is not consistent with the information contained in the CMOS RAM, whenever the CMOS RAM has lost power, or the system features need to be changed.



Default Configuration

Most of the configuration settings are either predefined according to the Load Optimal Defaults settings which are stored in the BIOS or are automatically detected and configured without requiring any actions. There are a few settings that you may need to change depending on your system configuration.

Entering Setup

When the system is powered on, the BIOS will enter the Power-On Self Test (POST) routines. These routines perform various diagnostic checks; if an error is encountered, the error will be reported in one of two different ways:

- If the error occurs before the display device is initialized, a series of beeps will be transmitted.
- If the error occurs after the display device is initialized, the screen will display the error message.

Powering on the computer and immediately pressing allows you to enter Setup.

Press the belkey to enter Setup:

Legends

Кеу	Function
← →	Moves the highlight left or right to select a menu.
	Moves the highlight up or down between sub- menus or fields.
Esc	Exits the BIOS Setup Utility.
+	Scrolls forward through the values or options of the highlighted field.
-	Scrolls backward through the values or options of the highlighted field.
Tab Hereita	Selects a field.
F1	Displays General Help.
F2	Load previous values.
F3	Load optimized default values.
F4	Saves and exits the Setup program.
Enter,	Press <enter> to enter the highlighted sub-menu</enter>

NECOM

Scroll Bar

When a scroll bar appears to the right of the setup screen, it indicates that there are more available fields not shown on the screen. Use the up and down arrow keys to scroll through all the available fields.

Submenu

When " \blacktriangleright " appears on the left of a particular field, it indicates that a submenu which contains additional options are available for that field. To display the submenu, move the highlight to that field and press from \Box .



BIOS Setup Utility

Once you enter the AMI BIOS Setup Utility, the Main Menu will appear on the screen. The main menu allows you to select from several setup functions and one exit. Use arrow keys to select among the items and press to accept or enter the submenu.

Main

The Main menu is the first screen that you will see when you enter the BIOS Setup Utility.

BIOS Information		Set the Date. Use Tab to
BIOS Vendor	American Megatrends	switch between Date elements.
Core Version	5.27	Default Ranges: Year: 1998–9999
Compliancy MCU Version	UEFI 2.8; PI 1.7 N/A	Months: 1-12
Project Version	RN15T1108 x64	Days: Dependent on month
Ruild Date and Time	07/24/2023 16:03:35	Range of Years may vary.
Product Name	NVIB 6604	Nange of Tears may vary.
Processor Information		
13th Gen Intel(R) Core(TM) i7-13700	DE	
ID	0×B0671	
Stepping	BO	
Microcode Revision	112	++: Select Screen
Total Memory	32768 MB	↑↓: Select Item
Memory Frequency	3200 MHz	Enter: Select
		+/-: Change Opt.
ME FW Version	16.1.25.2101	F1: General Help
IGFX GOP Version	17.0.1073	F2: Previous Values
		F3: Optimized Defaults
System Date	[Thu 08/31/2023]	F4: Save & Exit ESC: Exit
System Time	[15:20:02]	
	(10.00.00)	
System Fine	[13-20-02]	

System Date

The date format is <day>, <month>, <date>, <year>. Day displays a day, from Monday to Sunday. Month displays the month, from January to December. Date displays the date, from 1 to 31. Year displays the year, from 1999 to 2099.

System Time

The time format is <hour>, <minute>, <second>. The time is based on the 24-hour military-time clock. For example, 1 p.m. is 13:00:00. Hour displays hours from 00 to 23. Minute displays minutes from 00 to 59. Second displays seconds from 00 to 59.



Advanced

The Advanced menu allows you to configure your system for basic operation. Some entries are defaults required by the system board, while others, if enabled, will improve the performance of your system or let you set some features according to your preference.



Setting incorrect field values may cause the system to malfunction.

PCH-FW Configuration Intel(R) Time Coordinated Computing Trusted Computing ACPI Settings NCT6126D Super ID Configuration Hardware Monitor PCI Subsystem Settings	Configure Management Engine Technology Parameters
USB Configuration	<pre>++: Select Screen 14: Select Item Enter: Select +/-: Change Opt, F1: General Help F2: Previous Values F3: Optimized Defaults</pre>
	F3: Save & Exit F4: Save & Exit ESC: Exit

PCH-FW Configuration

This section is used to view CPU status and configure CPU parameters.

Advanced	Aptio Setup – AMI	
ME Firmware Version ME Firmware Mode ME Firmware Status 1 ME Firmware Status 1 ME Firmware Status 3 ME Firmware Status 3 ME Firmware Status 4 ME Firmware Status 5 ME Firmware Status 6	16.1.25.2101 Normal Mode Corporate SKU 0x90000255 0x90958106 0x00000000 0x00004000 0x00004000 0x00000000	When Disabled ME will be put into ME Temporarily Disabled Mode.
ME State AMT BIOS Features AMT Configuration	[Enabled] [Enabled]	++: Select Screen
Firmware Update Configuration Extend CSME Measurement to TPM-PCR	[Disabled]	11: Select Item Enter: Select +/-: Change Opt. F1: General Help F2: Previous Values F3: Optimized Defaults F4: Save & Exit ESC: Exit
Version 2	2.22.1288 Copyright (C) 20	D23 AMI

ME State

When disabled ME will be put into ME Temporarily Disabled Mode.

AMT BIOS Features

Enable or disable AMT BIOS Features.

AMT Configuration

Enter the AMT Configuration sub-menu.



Firmware Update Configuration

Enter the Firmware Update Configuration sub-menu.

Extend CSME Measurement to TPM-PCR

Enable or disable Extend CSME Measurement to TPM-PCR.

AMT Configuration

Advanced	Aptio Setup – AMI	
Activate Remote Assistance Process	[Disabled]	Enable/Disable of AMT USB Provisioning.
		<pre>+: Select Screen 11: Select Item Enter: Select +/-: Change Opt. F1: General Help F2: Previous Values F3: Optimized Defaults F4: Save & Exit ESC: Exit</pre>
Version 2	.22.1288 Copyright (C) :	2023 AMI

USB Provisioning of AMT

Enable or disable USB Provisioning of AMT.

MAC Pass Through Enable or disable MAC Pass Through.

Dynamic Lan Switch Configure AMT support from Integrated LAN to Discrete LAN.

Activate Remote Assistance Process

Enable or disable Activate Remote Assistance Process.



Unconfigure ME Enable or disable unconfigure ME.

ASF Configuration Enter the ASF Configuration sub-menu.

Secure Erase Configuration Enter the Secure Erase Configuration sub-menu.

One Click Recovery(OCR) Configuration Enter the One Click Recovery(OCR) Configuration sub-menu.

Remove Platform Erase Configuration

Enter the Remove Platform Erase Configuration.

AMT Configuration > ASF Configuration

Aptio Setup - AMI Advanced		
PET Progress WatchDog OS Timer BIOS Timer ASF Sensors Table	(Enabled) (Disabled) 0 (Disabled) (Disabled)	Enable/Disable PET Events Progress to receive PET Event
		<pre>++: Select Screen 14: Select Item Enter: Select +/-: Change Opt. F1: General Help F2: Previous Values F3: Optimized Defaults F4: Save & Exit ESC: Exit</pre>

PET Progress

Enable or disable PER events progress to receiver PET Events.

WatchDog

Enable or disable watchdog.

ASF Sensors Table

Enable or disable ASF Sensors Table.



AMT Configuration > Secure Erase Configuration



Secure Erase mode

Configure the Secure Erase module behavior.

Simulated: Performs SE flow without erasing SSD. Real: Erases SSD.

Force Secure Erase

NEXCOM

Enable or disable the option to Force Secure Erase on next boot.



Advanced	Aptio Setup – AMI	
OCR Hitps Boot OCR FBA Boot OCR Mindows Recovery Boot OCR Disable Secure Boot	[Enabled] [Enabled] [Enabled] [Enabled]	Enable∕Disable One Click Recovery Https Boot
		<pre>+*: Select Screen 11: Select Item Enter: Select +/-1 Change Opt. F1: General Help F2: Previous Values F3: Optimized Defaults F4: Save & Exit ESC: Exit</pre>
Vers	ion 2.22.1288 Copyright (C) 2023 AMI

OCR Https Boot

Enable or disable OCR Https Boot.

OCR PBA Boot Enable or disable OCR PBA Boot.

OCR Windows Recovery Boot Enable or disable OCR Windows Recovery Boot.

OCR Disable Secure Boot Enable or disable OCR Disable Secure Boot



AMT Configuration > Remove Platform Erase Configuration

Advanced	Aptio Setup – AMI	
		Enable/Disable Remote Platform Erase Feature
SSD Erase Mode	[Simulated]	
		<pre>++: Select Screen 14: Select Item Enter: Select +/-: Change Dpt. F1: General Help F2: Previous Values F3: Optimized Defaults F4: Save & Exit ESC: Exit</pre>
Versic	n 2.22.1288 Copyright (C)	2023 AMI

Enable Remove Platform Erase Feature

Enable Remove Platform Erase Feature.

SSD Erase Mode

Configure the SSD Erase Mode.

Firmware Update Configuration

Advanced		
Me FW Image Re-Flash FW Update	(Disabled) [Enabled]	Enable/Disable Me FW Image Re-Flash function.
		++: Select Screen 14: Select Item Enter: Select +/-: Change Opt. F1: General Help F2: Previous Values F3: Optimized Defaults F4: Save & Exit ESC: Exit

ME FW Image Re-Flash

Enable or disable ME FW Image Re-Flash function.

FW Update

Enable or disable FW Update



Intel(R) Time Coordinated Computing



C states

Enter the C states sub-menu.

Hyper-Threading

Enter the Hyper-Threading sub-menu.

C States

CPU – Power Management Control		Enable/Disable CPU Power Management. Allows CPU to go
Boot performance mode Intel(R) SpeedStep(tm) Turbo Mode C states	[Turbo Performance] [Enabled] [Enabled] [Enabled]	nanagement. Hildus ero to ge to C states uhen it's not IC utilized.
		++: Select Screen 11: Select Item Enter: Select +/-: Change Opt, F1: General Help F2: Previous Values F3: Optimized Defaults F4: Save & Exit ESD: Exit

Boot performance mode

Configure the performance mode of the CPU.

Intel(R) SpeedStep(tm)

Enable or disable Intel SpeedStep technology.

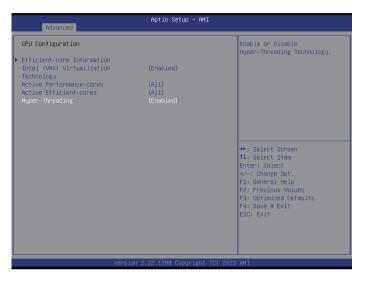
Turbo Mode Enable or disable turbo mode.

C states

Enable or disable CPU Power Management. Allows CPU to go to C states when it's not 100% utilized.



Hyper-Threading



Efficient-core Information

Enter the Efficient-core Information sub-menu.

Intel (VMX) Virtualization Technology

When this field is set to Enabled, the VMM can utilize the additional hardware capabilities provided by Vanderpool Technology.

Active Performance-cores

Select the quantity of performance cores to enable in each processor package.

Active Efficient-cores

Select the quantity of efficient cores to enable in each processor package.

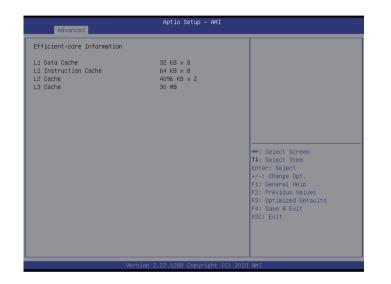
Hyper-Threading

Enable or disable Hyper-Threading Technology.



Hyper-Threading > Efficient-core Information

Display the information of the efficient-core.



Trusted Computing

TPM 2.0 Device Found		Enables or Disables BIOS
Firmware Version:	7.62	support for security device
Vendor:	IFX	O.S. will not show Security
Security Device Support		Device. TCG EFI protocol and INT1A interface will not be
Active PCR banks	SHA256	available.
Available PCR banks	SHA256	avartabre.
SHA256 PCR Bank	[Enabled]	
Pending operation	[None]	
Platform Hierarchy	[Enabled]	
	[Enabled]	++: Select Screen
Endorsement Hierarchy Physical Presence Spec Version	[Enabled] [1.3]	11: Select Item
TPM 2.0 InterfaceType	[1.3] [TIS]	Enter: Select
Device Select	[Auto]	+/-: Change Opt.
		F1: General Help
		F2: Previous Values
		F3: Optimized Defaults
		F4: Save & Exit
		ESC: Exit

Security Device Support

Enable or disable BIOS support for security device. O.S. will not show Security Device. TCG EFI protocol and INT1A interface will not be available.

SHA256 PCR Bank

Enable or disable SHA256 PCR Bank.

Pending operation

Schedule an operation for the security device.

Platform Hierarchy

Enable or disable platform hierarchy.



Storage Hierarchy

Enable or disable storage hierarchy.

Endorsement Hierarchy

Enable or disable endorsement hierarchy.

Physical Presence Spec Version

Configure the physical presence spec version.

Device Select

TPM 1.2 will restrict support to TPM 1.2 devices. TPM 2.0 will restrict support to TPM 2.0 devices. Auto will support both TPM 1.2 and 2.0 devices with the default set to TPM 2.0 devices if not found, and TPM 1.2 devices will be enumerated.

ACPI Settings

ACPI Settings		Enables or Disables System ability to Hibernate (OS/S4 Sleep
Enable Hibernation ACPI Sleep State	[Enabled] [S3 (Suspend to RAM)]	State). This option may not be effective with some operating systems.
		++: Select Screen ↑↓: Select Item
		Enter: Select +/-: Change Opt. F1: General Help F2: Previous Values
		F2: Frevious values F3: Optimized Defaults F4: Save & Reset ESC: Exit

Enable Hibernation

Enable or disable system ability to hibernation (OS/S4 Sleep State). This option may not be effective with some operating systems.

ACPI Sleep State

Select the highest ACPI sleep state the system will enter when the suspend button is pressed.



NCT6126D Super IO Configuration



Enable Hibernation

Enter the Serial Port 1 Configuration sub-menu.

Serial Port 1 Configuration

Serial Port 1 Configuration		Enable or Disable Serial Por
Serial Port Device Settings Onboard Serial Port Mode	[Enabled] IO=3F8h; IRQ=4; [RS232]	(COM)
Change Settings	[Auto]	
		++: Select Screen 14: Select Item Enter: Select +/-: Change Opt. F1: General Help F2: Previous Values F3: Optimized Defaults F4: Save & Exit ESC: Exit

Serial Port

Enable or disable serial port (COM).

Onboard Serial Port Mode

Configure the serial port mode to RS232 or RS485 Auto.

Changes Settings

Select an optimal setting for the Super IO device.



Hardware Monitor

This section is used to monitor hardware such as temperature, fan speed, and voltages.

Advanced	Aptio Setup – AMI	
Advanced Pc Health Status CPU PECI Temperature/BT2(SYSTIN) Fan1/SYS1 Speed Fan3 Speed Fan4/SYS3 Speed +3.3V +5V +12V VCORE > Smart Fan Function	: +57 °c	Smart Fan function setting +-: Select Screen N: Select Item Enter: Select +/-: Change Dpt. F1: General Help F2: Previous Values F3: Optimized Defaults F4: Save 8 Exit ESC: Exit
Version) 2.22.1288 Copyright (C)	2023 AMI

Smart Fan Function

Enter the Smart Fan Function sub-menu.

Smart Fan Function

	Smart Fan function setting
▶ Fan2 Setting	ondite Full Fullection Secting
▶ Fan3 Setting	
▶ Fan4 Setting	
	++: Select Screen
	↑↓: Select Item
	Enter: Select
	+/-: Change Opt.
	F1: General Help F2: Previous Values
	F3: Optimized Defaults
	F4: Save & Exit
	ESC: Exit

Fan1/2/3/4 Setting Enter the Fan1/2/3/4 Setting sub-menu.



Smart Fan Function > Fan1/2/3/4 Setting

an1 Setting		Fan control mode select
Fani Mode		Fair control mode select
Step up time	[3000X1 1 00X 1 V]	
Step down time	1	
Temperature 1	25	
Temperature 2	35	
Temperature 3	45	
Cemperature 4	55	
FD/RPM 1	105	
D/RPM 2	150	
D/RPM 3	190	
D/RPM 4	230	
Critical temperature	60	
Critical tolerance	0	→+: Select Screen
Enable critical duty	[Disabled]	14: Select Item
Tolerance value	0	Enter: Select
RPM Mode	[Disabled]	+/-: Change Opt.
Fanout stepping	[Enabled]	F1: General Help
an1 Monitor	[BT2/SYSTIN]	F2: Previous Values
	201210101111	F3: Optimized Defaults
		F4: Save & Exit
		ESC: Exit
		LOOP ENT

Fan1/2/3/4 Mode

Configure the fan mode.

Step up time

The amount of time fan takes to increase its value by one step.

Step down time

The amount of time fan takes to decrease its value by one step.

Temperature 1/2/3/4 (Fan1/2/3/4)

Configure the temperature setting.

FD/RPM 1/2/3/4 (Fan1/2/3/4)

The value of Fan Duty/RPM when temperature is T1 to T4.

Critical temperature (Fan1/2/3/4)

Configure the time that fan out requires for reducing its value by one step.

Critical tolerance (Fan1/2/3/4) Configure the tolerance of critical temperature.

Enable critical duty (Fan1/2/3/4)

Enables critical duty, if enabled, it will use critical duty value for fan out. If not will use full speed for fan out.

RPM Mode (Fan1/2/3/4)

Enable or disable Smart Fan IV close loop fan control RPM Mode.

Fanout stepping (Fan1/2/3)

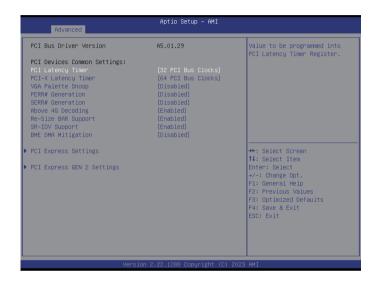
Enable or disable Smart Fan IV stepping.

Fan1/2/3/4 Monitor (Fan1/2/3/4)

Select a mode for fan monitor.



PCI Subsystem Settings



PCI Latency Timer

Value to be programmed into PCI Latency Timer Register.

PCI-X Latency Timer

Value to be programmed into PCI-X Latency Timer Register.

VGA Palette Snoop Enable or disable the VGA palette registers snooping.

PERR# Generation

Enable or disable the PCI device to generate PERR#.

SERR# Generation Enable or disable the PCI device to generate SERR#.

Above 4G Decoding Enable or disable decoding of 64-bit devices in 4G address space.

Re-Size BAR Support Enable or disable Re-Size BAR support.

SR-IOV Support Enable or disable SR-IOV support.

BME DMA Mitigation Enable or disable BME DMA Mitigation support.

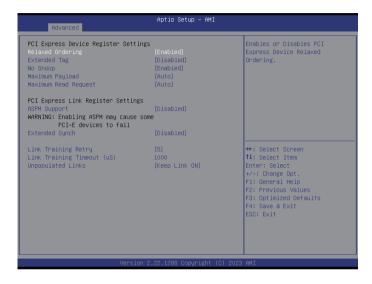
PCI Express Settings Enter the PCI Express Settings sub-menu.

PCI Express Gen 2 Settings

Enter the PCI Express Gen 2 Settings sub-menu.



PCI Express Settings



Relaxed Ordering

Enable or disable PCI Express Device Relaxed Ordering.

Extended Tag

Enable or disable Extended Tag.

No Snoop Enable or disable No Snoop.

Maximum Payload

Select the maximum TLP payload size of the PCI Express devices.

Maximum Read Request

Select the maximum read request size of the PCI Express devices.

ASPM Support

Select the ASPM level.

ForceL0 Forces all links to L0 state.AutoThe BIOS automatically selects an ASPM level.DisableDisables ASPM.

Extended Synch

When this function is enabled, it allows generation of extended synchronization patterns.

Link Training Retry

Select the number of retry attempts.

Link Training Timeout (US)

Select the timeout period of link training in microseconds.

Unpopulated Links

Enable or disable unpopulated PCI Express links.



PCI Express Gen 2 Settings



Completion Timeout

In device functions that support Completion Timeout programmability, allows system software to modify the Completion Timeout value.

ARI Forwarding

Enable or disable ARI Forwarding.

AtomicOp Requester Enable Enable or disable AtomicOp Requester Enable.

Atomic0p Egress Blocking Enable or disable Atomic0p Egress Blocking. **IDO Request Enable** Enable or disable IDO Request Enable.

IDO Completion Enable Enable or disable IDO Completion Enable.

LTR Mechanism Enable Enable or disable LTR Mechanism Enable.

End-End TLP Prefix Blocking Enable or disable End-End TLP Prefix Blocking.

Target Link Speed Configure the PCIe link speed.

Clock Power Management Enable or disable Clock Power Management.

Compliance SOS Enable or disable Compliance SOS.

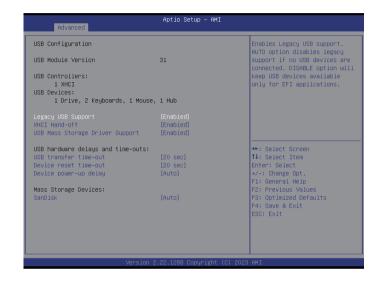
Hardware Autonomous Width Enable or disable Hardware Autonomous Width.

Hardware Autonomous Speed

Enable or disable Hardware Autonomous Speed.



USB Configuration



Legacy USB Support

Enabled Enable legacy USB.

Auto Disable support for legacy when no USB devices are connected. Disabled Keep USB devices available only for EFI applications.

XHCI Hand-off

This is a workaround for OSs that does not support XHCI hand-off. The XHCI ownership change should be claimed by the XHCI driver.

USB Mass Storage Driver Support

Enable or disable USB mass storage driver support.

USB transfer time-out

The time-out value for control, bulk, and Interrupt transfers.

Device reset time-out

Selects the USB mass storage device's start unit command timeout.

Device power-up delay

Maximum time the value will take before it properly reports itself to the Host Controller. "Auto" uses default value: for a Root port it is 100 ms, for a Hub port the delay is taken from Hub descriptor.

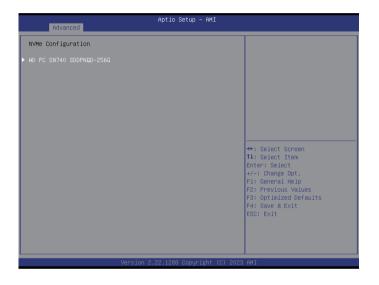
Mass Storage Devices

Configure the mass storage device emulation type. AUTO enumerates devices according to their media format. Optical drives are emulated as CDROM, drives with no media will be emulated according to a drive type.



NVMe Configuration

This section is used to display information on the NVMe devices installed. Click on the installed device for more detailed configuration.



Self Test Option

Configure the method used for self test. Short: Short option will take couple of minutes to complete. Extended: Extended option will take several minutes to complete.

Self Test Action

Configure the items used for self test. Controller Only Test and Controller and NameSpace Test options are available. Selecting Controller and NameSpace Test will take longer to complete.



Chipset

This section gives you functions to configure the system based on the specific features of the chipset. The chipset manages bus speeds and access to system memory resources.

System Agent (SA) Configuration PCH–IO Configuration	System Agent (SA) Parameters
	↔: Select Screen 1↓: Select Item
	Enter: Select +/-: Change Opt.
	F1: General Help
	F2: Previous Values F3: Optimized Defaults
	F4: Save & Exit
	ESC: Exit

System Agent (SA) Configuration

Enter the System Agent (SA) Configuration sub-menu.

PCH-IO Configuration

Enter the PCH-IO Configuration sub-menu.

System Agent (SA) Configuration

System Agent (SA) Configuration		Graphics Configuration
 Graphics Configuration VMD setup menu 		
X16 Mode Select VT-d	[1X16] [Enabled]	
		++: Select Screen 14: Select Item Enter: Select +/-: Change Opt. F1: General Help F2: Previous Values F3: Optimized Defaults F4: Save & Exit ESC: Exit

Graphics Configuration Enter the Graphics Configuration sub-menu.

VMD setup menu

Enter the VMD setup menu sub-menu.

X16 Mode Select

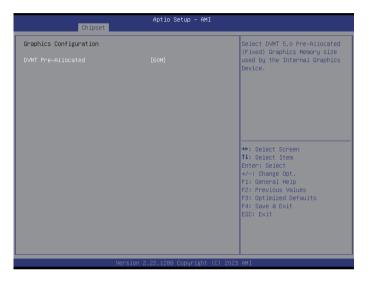
Select a PCIe mode.

VT-d

Enable or disable Intel® VT-d technology.



Graphics Configuration



DVMT Pre-Allocated

Select DVMT 5.0 Pre-Allocated (Fixed) Graphics Memory size used by the Internal Graphics Device.

VMD setup menu

VMD Configuration	Enable/Disable to VMD
	Controller
	++: Select Screen T4: Select Item Enter: Select +/-: Change Oct. F1: General Helo F2: Previous Values
	F3: Optimized Defaults F4: Save & Exit ESC: Exit

Enable VMD controller

Enable or disable to VMD controller.



PCH-IO Configuration



SATA Configuration

Enter the SATA Configuration sub-menu.

State After G3

Configure the power state when power is re-applied after a power failure (G3 state).

SATA Configuration

SATA Configuration		Enable/Disable SATA Device.
SATA Controller(s)		
SATA Mode Selection	[AHCI]	
SATA Test Mode	[Disabled]	
Aggressive LPM Support	[Enabled]	
Serial ATA Port O	KINGSTON OM4PO (128.0G	3)
Software Preserve	SUPPORTED	
Port 0	[Enabled]	
Hot Plug	[Enabled]	
Configured as eSATA	Hot Plug supported	
External	[Disabled]	· · · · · · · · · · · · · · · · · · ·
Mechanical Presence Switch	[Disabled]	→+: Select Screen
Spin Up Device	[Disabled]	t↓: Select Item
SATA Device Type	[Hard Disk Drive]	Enter: Select
Topology	[Unknown]	+/-: Change Opt.
SATA Port 0 DevS1p	[Enabled]	F1: General Help
DITO Configuration	[Disabled]	F2: Previous Values
DITO Value	625	F3: Optimized Defaults
DM Value	15	F4: Save & Exit
Serial ATA Port 4	HGST HUH721212	ESC: Exit
	(12000.1GB)	
Software Preserve	SUPPORTED	
Port 4	[Enabled]	▼

SATA Controller(s)

Enable or disable the SATA controller.

SATA Mode Selection

Configure the SATA mode.

AHCI: This option configures the Serial ATA drives to use AHCI (Advanced Host Controller Interface). AHCI allows the storage driver to enable the advanced Serial ATA features which will increase storage performance.

SATA Test Mode

Enable or disable SATA test mode.



Aggressive LPM Support Enable or disable Aggressive LPM Support.

Serial ATA Port 0~4 Port Enable or disable SATA port.

Hot Plug Enable or disable hot plugging feature.

External Enable or disable the external SATA option.

Mechanical Presence Switch Enable or disable reporting of whether port 0 has a mechanical presence switch. **Note:** Requires hardware support.

Spin Up Device Enable or disable staggered spin up on devices connected to SATA.

SATA Device Type Identify what type of SATA device is connected.

Topology Identify what type of SATA connection is used.

SATA Port 0 DevSlp Enable or disable SATA port 0 DevSlp. Before enabling DevSlp, board rework is needed.

DITO Configuration Enable or disable DITO configuration for SATA port 0.

NE(COM



Security



Administrator Password

Select this to reconfigure the administrator's password.

Secure Boot

Enter the Secure Boot sub-menu.

TCG Storage Security Configuration

Configure the TCG storage security. The item shown here depends on the storage device you have connected.

Secure Boot

System Mode	Setup	Secure Boot feature is Active
Secure Boot	[Disabled] Not Active	if Secure Boot is Enabled, Platform Key(PK) is enrolled and the System is in User mod The mode change requires
Secure Boot Mode ▶ Restore Factory Keys ▶ Reset To Setup Mode	[Custom]	platform reset
▶ Key Management		
		++: Select Screen
		↑↓: Select Item Enter: Select
		+/-: Change Opt. F1: General Help F2: Previous Values
		F3: Optimized Defaults F4: Save & Exit ESC: Exit
		COULCART .

Secure Boot

Secure boot feature is active if secure boot is enabled. Platform Key (PK) is enrolled and the system is in user mode. The mode change requires platform reset.

Secure Boot Mode

Select to configure the secure boot mode.

Standard: Fixed secure boot policy.

Custom: Changeable Image Execution policy and Secure Boot key databases.

NEXCOM

Restore Factory Keys

Enter the Restore Factory Keys sub-menu.

Key Management

Enter the Key Management sub-menu.

Restore Factory Keys

Vendor Keys	Valid	Install factory default Secur
Factory Key Provision • Restore Factory Keys • Reset To Setup Mode • Enroll Efi Image • Export Secure Boot variables		Boot keys after the platform reset and while the System is in Setup mode
Secure Boot variable Size Platform Key (PK) 0 Key Exchange Keys (NEK) 0 Authorized Signatures (db) 0 Forbidden Signatures(db) 10616 Authorized TimeStamps(db1) 0 OSRecovery Signatures(dbr) 0	0 No Keys 0 No Keys 0 No Keys 220 Modified	<pre>**: Select Screen 14: Select Item Enter: Select */-: Change Opt. F1: General Help F2: Previous Values F3: Optimized Defaults F4: Save & Exit ESC: Exit</pre>

Factory Key Provision

Install factory default secure boot keys after the platform reset and while the system is in Setup mode.

Restore Factory Keys

Force system into User Mode. Install factory default Secure Boot Key databases.

Reset To Setup Mode

Delete all Secure Boot key databases from NVRAM.



Enroll Efi Image

Run the image in Secure Boot Mode.

Export Secure Boot Variables

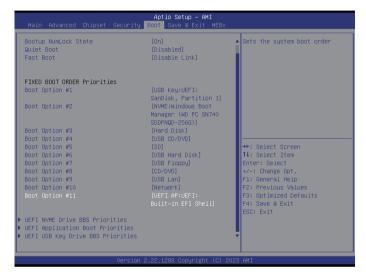
Copy NVRAM content of Secure Boot variables to files in a root folder on a file system device.

Platform Key (PK) / Key Exchange Keys / Authorized Signatures / Forbidden Signatures / Authorized TimeStamps / OsRecovery Signatures

Enroll factory defaults or load the keys from a file.



Boot



Bootup NumLock State

Set the system boot order.

Quiet Boot

Enable or disable the quiet boot function.

Fast Boot

Enable or disable boot with initialization of a minimal set of devices required to launch active boot option. This doesn't affect the BBS boot options.

FIXED BOOT ORDER PRIORITIES Boot Option 1~11

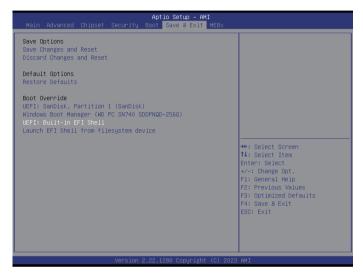
Adjust the boot sequence of the system. Boot Option #1 is the first boot device that the system will boot from, next will be Boot Option #2 and so forth.

UEFI NVMe Drive BBS Priorities / UEFI Application Boot Priorities / UEFI USB Key Drive BBS Priorities

Configure the boot device priority sequence from available UEFI key drives.



Save & Exit



Save Changes and Reset

To save the changes and reset, select this field then press <Enter>. A dialog box will appear. Confirm by selecting Yes.

Discard Changes and Reset

To exit the Setup utility and reset without saving the changes, select this field then press <Enter>. You may be prompted to confirm again before exiting.

Restore Defaults

To restore the BIOS to default settings, select this field then press <Enter>. A dialog box will appear. Confirm by selecting Yes.

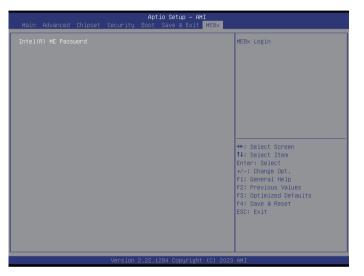
Boot Override

To bypass the boot sequence from the Boot Option List and boot from a particular device, select the desired device and press <Enter>



MEBx

.



Intel(R) ME Password

Press to enter the Intel(R) ME Password sub-menu. Refer to Appendix A for more detailed configurations.



Intel(R) Rapid Storage Technology

Aptio Setup – AMI Main Advanced Chipset Security Boot Save & Exit MEBx	Intel(R) Rapid Storage Technology
Intel(R) RST 19.5.0.5676 RST VMD Driver ▶ Create RAID Volume	This page allows you to create a RAID volume
Non-RAID Physical Disks: > SATA 0.0, KINGSTON 0M4P0S31280-A0 5002687685F0FCD3, 119.268 > SATA 0.4, WDC WD80FUZX-64NEAY0 R665J20Y, 7.2TB > SATA 0.5, NDC W080FUZX-64NEAY0 XJ383J0X, 7.2TB > SATA 0.7, NDC W080FUZX-64NEAY0 R665K15Y, 7.2TB	
	<pre>+*: Select Screen 14: Select Item Enter: Select +/-: Change Opt. F1: General Help F2: Previous Values F3: Optimized Defaults F4: Save & Exit ESC: Exit</pre>
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Create RAID Volume

This page allows you to create a RAID volume and suggests referring to Appendix C: NViS 5704 RAID Configuration for more detailed operations.



APPENDIX A: NVIS 5704 INTEL AMT CONFIGURATION

 Press the <Delete> button to enter the BIOS when turning on or rebooting the system. Navigate to the MEBx tab within the BIOS menu. Press <Enter> button to access this feature. By default, the password is "admin."

Aptio Setup – AMI Main Advanced Chipset Security Boot Save & Exit <mark>MEBx</mark>	
Intel(R) ME Password	HEBx Login ++: Select Screen 14: Select Item Enter: Select +-: Change Opt. F1: General Help F2: Frevious Values F3: Optimized Defaults F4: Save & Reset ESC: Exit
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2. You may change the password by going to **Change ME Password**. The password must be at least 8 characters long and include a combination of uppercase letters, lowercase letters, numbers, and symbols. For example, !QAZ1qaz

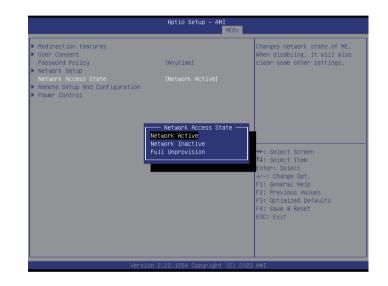
Aptio Setup – AMI Main Advanced Chipset Security Boot Save & Exit MEBX	
Intel(R) Standard Manageability [Enabled] Intel(R) Standard Manageability Configuration Intel(R) OEM Debug Configuration Change HE Password	++: Select Screen 14: Select Item Enter: Select +/-: Chage Opt. F1: General Help F2: Previous Values F3: Optimized Defaults F4: Save & Reset ESC: Exit
Version 2.22.1284 Copyright (C) 20	D23 AMI



 Follow these steps to navigate the configuration items: Intel(R) Standard Manageability Configuation > User Consent > User Opt-in, then select All.

	Aptio Setup – AMI MEBX	
User Opt-in Opt-in Configurable from Remote IT	[NONE]	Configure When User Consent Should be Required
Version 2	.22.1284 Copyright (C) 2023	3 AMI

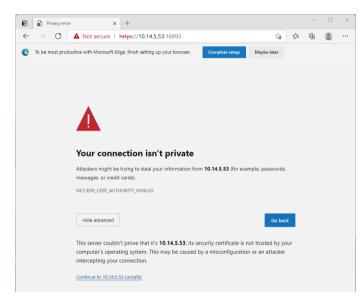
 Follow these steps to navigate the configuration items: Intel(R) Intel
 (R) Standard Manageability Configuation > Network Access State, then change the option to Network Active.



5. Return to the BIOS main menu, navigate to the **Save & Exit** tab, and click **Save Changes and Reset** to apply the settings.



- Enter the operating system and log in to the IAMT configuration web page using https://ipaddress_of_PC:16993 For example:
 - 6-1. https://10.14.5.53:16993

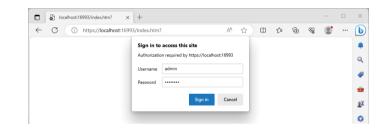




Click the **Continue** if a warning message appears to remind you that the connection isn't private.



- 6-2. Account: adimin
- 6-3. Password: The password you have changed in step 1.





Alternatively, you can access IAMT configuration page by https://127.0.0.1:16993 or https://localhost:16993 on local side.



7. The screen should look like the image shown below after a successful login.

\leftarrow C (\blacktriangle	lot secure https://127	.0.0.1:16993/index.htm?	A* 🖒	() {≦	÷		•••
Computer:	nagement Techno	blogy				inte	I. Î
System Status Hardware Information	System Status						1
System Processor	Power	On					1
Memory	IP address	10.14.5.53					- 1
Disk	IPv6 address	Disabled					
Event Log Power Policies	System ID	03000200-0400-0500	-0006-000700080009				- 1
Network Settings	Date	9/8/2023					- 1
Pv6 Network Settings	Time	1:12 am					
System Name Settings User Accounts	Refresh						
Web Applications Links							
	Copyright @ 2005-2022	Intel Corporation. All Rights Reserved	Intel® Active Management Tech	hnology firmware	version: 16.1.25-	build 2124	
							- 8

8. Follow the same login procedure as outlined in step 6 using the same address, account, and password. Ensure that the remote control system is in the same network segment as the target system.

9. Once logged in successfully, you will see the remote control page shown below.

Intel® Active Manage	ement Tec × +					~	-		×
← → C ▲ 不3	安全 https://10.14.5.	53:16993/index.htm?	G	Gr	Ê	☆	*		:
Intel [®] Active Man Computer:	agement Techno	blogy						inte	el.
System Status Hardware Information	System Status								
System	Power	On							
Processor Memory	IP address	10.14.5.53							
Disk	IPv6 address	Disabled							
Event Log	System ID	03000200-040	0-050	0-000	6-0007	700080	009		
Remote Control Power Policies	Date	9/8/2023							
Network Settings	Time	5:51 am							
IPv6 Network Settings System Name Settings	Refresh								
User Accounts Web Applications Links		Intel Corporation. All Ri chnology firmware versio					Active	Managen	ent

S Intel® Active Manage	ement Tec × +	~ -	- 0	×
← → C ▲ 不弱	安全 https://10.14.5.53:16993/remote.h G 🔤 🖻	* * *		:
Intel [®] Active Mana Computer:	agement Technology		int	el.
System Status Hardware Information System Processor Memory Disk Event Log Remote Control Power Policies Network Settings Power Policies System Name Settings User Accounts Web Applications Links	Remote Control Power state: On Send a command to this computer:		00t A	



APPENDIX B: GPIO INSTRUCTION

Locating the GPIO Connector

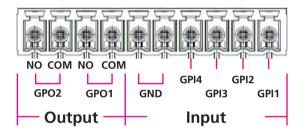


The GPIO function is an optional feature. If available, the GPIO expansion board comes pre-installed on the system by default.

• This device boasts a 10-pin GPIO pin conveniently located on its rear panel. This versatile digital pin, controlled by software, can function as an input, output, or both, allowing you to customize its behavior and connect with various external devices.

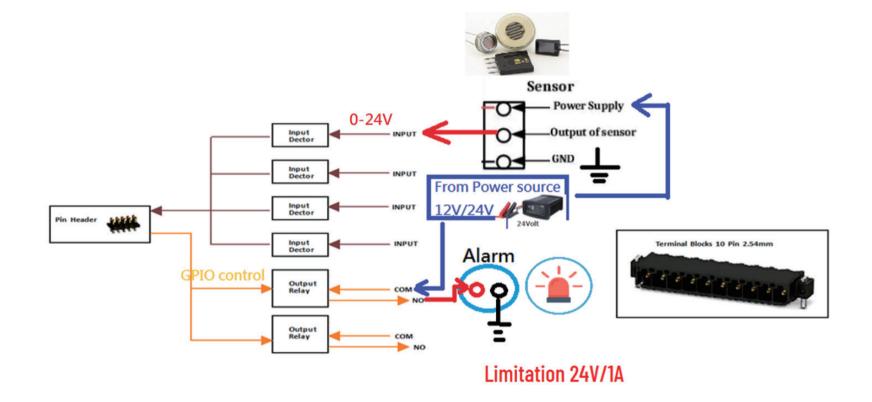


Understanding GPIO Pin Definitions





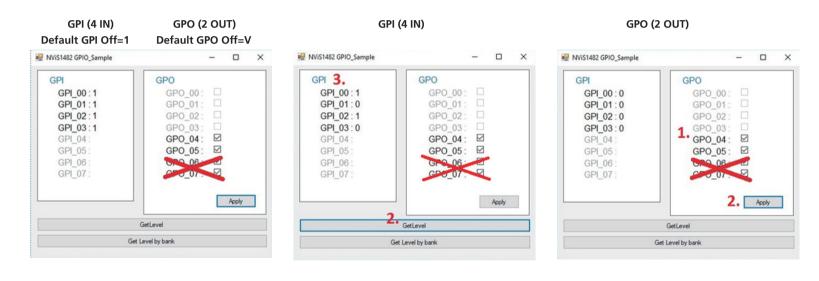
ISO GPIO 4in_2out Block Diagram





Basic Configuration

- 1. Download the software from the official website, unzip the file and run the **RN15_GPIO_Sample.exe** file.
- 2. Follow the images below for configuring the GPIO.





APPENDIX C: NVIS 5704 RAID CONFIGURATION

1. Press the <Delete> button to access the BIOS during the boot-up process. Once in the BIOS, navigate to the Chipset tab.

▶ PCH-IO Configuration	
	<pre>*: Select Screen 4: Select Item three: Select Screen 4: Seve Bent Screen Scre</pre>

2. Within the Chipset tab, find the System Agent (SA) Configuration and then go to the VMD Setup menu.

Chipset	Aptio Setup – AMI	
System Agent (SA) Configuration		Graphics Configuration
▶ Graphics Configuration ▶ VMD setup menu		
X16 Mode Select VT-d	[1X16] [Enabled]	
		++: Select Screen 11: Select Item Enter: Select +/-: Change Opt. F1: General Help F2: Previous Values F3: Optimized Defaults F4: Save A Exit ESC: Exit
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3. Enable the VMD controller.

Chipset	Aptio Setup – AMI	
VMD Configuration		Enable/Disable to VMD controller
Enable VMD controller		Controller
		<pre>++: Select Screen f4: Select Item Enter: Select +/-: Change Opt. F1: General Help F2: Previous Values P3: Optimized Defaults F4: Save & Exit ESC: Exit</pre>
V	ersion 2.22.1288 Copyright (C	C) 2023 AMI

4. Once enabled, save the changes and exit the BIOS to apply the settings.

VMD Configuration		Enable/Disable to VMD controller
Enable VMD Global Mapping Map this Root Port under VMD Root Port BDF details	[Enabled] [Disabled] 0/6/0	
Map this Root Port under VMD Root Port BDF details	[Disabled] SATA Controller	
RAIDO	[Enabled]	
RAID1 RAID5	[Enabled] [Enabled]	++: Select Screen
RAID10	[Enabled]	14: Select Item
Intel Rapid Recovery Technology		Enter: Select
RRT volumes can span internal and eSATA drives	[Enabled]	+/-: Change Opt. F1: General Help
Intel(R) Optane(TM) Memory	[Enabled]	F2: Previous Values F3: Optimized Defaults F4: Save & Exit ESC: Exit



5. Enter the BIOS again and navigate to the Intel(R) Rapid Storage Technology tab, then select **Create RAID Volume**.

Aptio Setup - AMI			
Main Advanced Chipset Security Boot Save & Exit MEBx I	ntel(R) Rapid Storage Technology		
Intel(R) RST 19.5.0.5676 RST VMD Driver	This page allows you to create a RAID volume		
▶ Create RAID Volume			
Non-RAID Physical Disks: > SATA 0.0, KINGSTON UM4P0S31280-A0 5002687685F0FCD9, 119.268 > SATA 0.4, MOC W060PUZ-64WERY0 K655J20Y, 7.278 > SATA 0.5, MOC W060PUZ-64WERY0 V3585J0K, 7.278 > SATA 0.6, MDC H060PUZ-64WERY0 K664NUUY, 7.278 > SATA 0.6, MDC H060PUZ-64WERY0 K665K15Y, 7.278 > SATA 0.7, MDC W060PUZ-64WERY0 K665K15Y, 7.278			
	++: Select Screen 14: Select Item Enter: Select +/-: Change Opt. F1: General Help F2: Previous Values F3: Optimized Defaults F4: Save & Exit ESC: Exit		
Version 2.22.1288 Copyright (C) 202	3 AMI		

6. Select the desired RAID level under the **RAID LEVEL** option.

	Aptio Setup – AMI		
		Intel(R) Rapid Storage Technology	
Create RAID Volume		Select RAID Level	
Name: RAID Level:	Volume1 [RAID10 (RAID0+1)]		
Select Disks: SATA 0.0, KINGSTON DM4POS31280-A0 S00268768576FC09, 119,288 SATA 0.4, HOC M080PUZX-64NEAYO R605J20Y, 7.2TB SATA 0.5, HOC M080PUZX-64NEAYO VJ0583J0X, 7.2TB SATA 0.6, HOC M080PUZX-64NEAYO R664NUUY, 7.2TB SATA 0.7, MDC M080PUZX-64NEAYO R665K15Y, 7.2TB	[] RAID Level: RAID0 (Stripe) RAID1 (Mirror) RAID5 (Reaity) RAID10 (RAID0+1)	→+: Select Screen 14: Select Item Enter: Select +/-: Change Dpt. F1: General Help	
Capacity (MB):	0	F2: Previous Values F3: Optimized Defaults	
▶ Create Volume		F4: Save & Exit ESC: Exit	
Select four disks			
Version 2.22.1288 Copyright (C) 2023 AMI			

.



7. Once you have completed the previou step, select **Create Volume** and press <Enter> to create RAID volum.

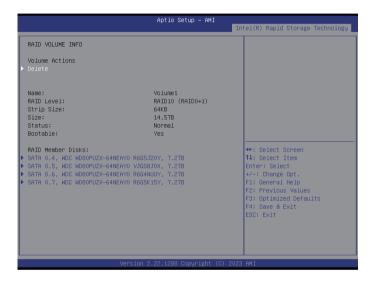
	Aptio Setup – AMI	Intel(R) Rapid Storage Technology
Create RAID Volume		Create a volume with the settings specified above
Name: RAID Level:	Volume1 [RAID10 (RAID0+1)]	
Select Disks: SATA 0.0, KINGSTON OM4POS3128Q-A0 5002687685F0FCD9, 119.268	[]	
SATA 0.4, WDC WD80PUZX-64NEAY0 R6G5J20Y, 7.2TB	[X]	
SATA 0.5, WDC WD80PUZX-64NEAY0 VJGSBJOX, 7.2TB	[X]	
SATA 0.6, WDC WD80PUZX-64NEAY0 R664NUUY, 7.2TB	[X]	
SATA 0.7, WDC WD80PUZX-64NEAYO R6G5K15Y, 7.2TB	[X]	t↓: Select Item Enter: Select +/-: Change Opt.
Strip Size: Capacity (MB):	[64KB] 15261766	F1: General Help F2: Previous Values
	12201/00	F3: Optimized Defaults
		F4: Save & Exit ESC: Exit
Version	2.22.1288 Copyright (C)	2023 AMI

8. The Volume 1 appears when the RAID volume is created. You can select Volume1 and press <Enter> to view the status or perform additional operations.

Aptio Setup – AMI Main Advanced Chipset Security Boot Save & Exit MEBx I	ntel(R) Rapid Storage Technology	
Intel(R) RST 19.5.0.5676 RST VMD Driver	Select to see more information about the RAID Volume	
RAID Volumes: • Volume1, RAID10 (RAID0+1), 14.5TB, Normal Non-RAID Physical Disks: • SATA 0.0, KINBSTON 0M4P0S3128Q-A0 5002687685F0FCD9, 119.268		
	<pre>+*: Select Screen 14: Select Item Enter: Select +/-: Change Opt. F1: General Help F2: Previous Values F3: Optimized Defaults F4: Save & Exit ESC: Exit</pre>	
Version 2.22.1288 Copyright (C) 2023 AMI		



9. Use the up or down arrow keys to navigate, review, or operate the options.





APPENDIX D: INSTALLING THE SYSTEM IN A RACK

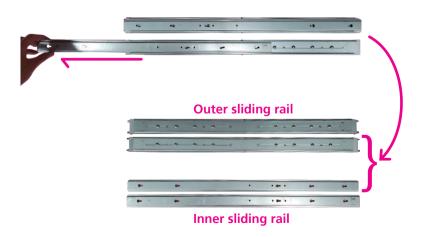
For Racks with a Depth Between 600~800mm

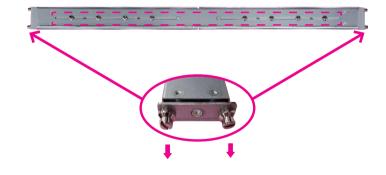


Before starting the installation procedure, check the package contents of the slide rails; it should contain: 4 x M4*6mm, 2 x M5*15mm, and 6 x M5*10mm screws

Outer Sliding Rail Installation

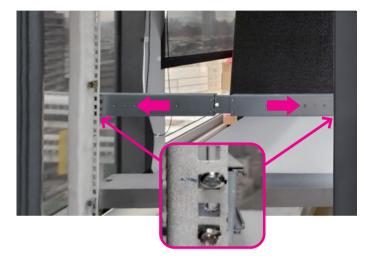
- 1. The slide rail kit consists of an inner and outer rail. Before starting the installation, detach the inner sliding rail from the outer one, and separate the inner and outer sliding rails.
- 2. Loosen the screws marked in the red dashed square in the image below on the outer sliding rails, but do not completely remove them. Then, remove the screws on both sides. (left and right sides).



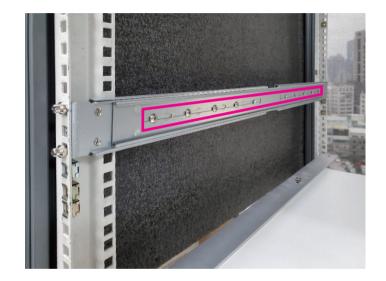




3. Pull the outer sliding rails apart and extend them to match the depth of the rack, then lock the front and rear screws.



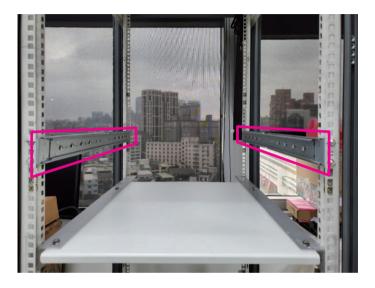
4. Tighten the screws that were loosened in step 2 to complete the installation, then repeat the same step to install the outer sliding rail on the other side.



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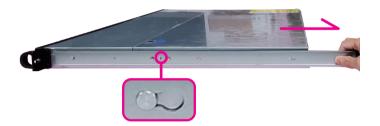
5. The outer sliding rail installation is complete.





Inner Sliding Rail Installation

1. Attach the inner sliding rail by aligning it with the three flush rivets on the system and inserting it through the larger mounting holes, then pull the rail backward until it clicks into place in the smaller holes.



2. Tighten the inner sliding rail using M4 screws, then repeat the same step to install the inner sliding rail on the other side.

3. The inner sliding rail installation is completed.

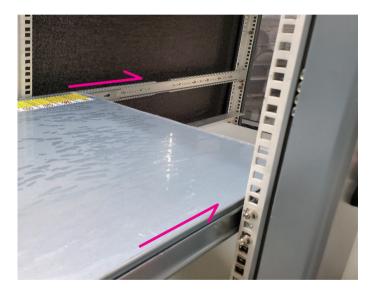






System Installation on Rack

1. Align the inner sliding rails installed on both sides of the system with the outer sliding rails installed on both sides of the rack, then gently slide the system into the rack.



2. The system installation on rack is completed.





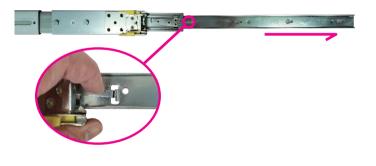
For Racks with a Depth Over 800~1000mm



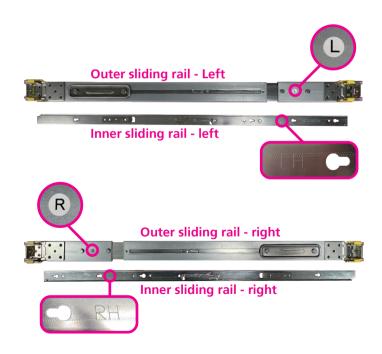
Before starting the installation procedure, check the package contents of the slide rails; it should contain: 2 x M4*11mm, 4 x M5*18mm

Outer Sliding Rail Installation

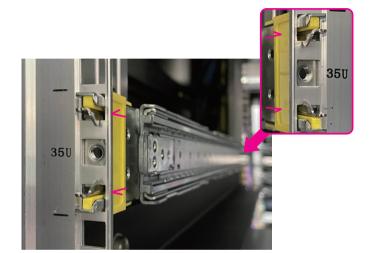
1. The slide rail kit consists of an inner and outer rail. Before starting the installation, detach the inner sliding rail from the outer one by pressing the release button on the outer rail and pulling it out.

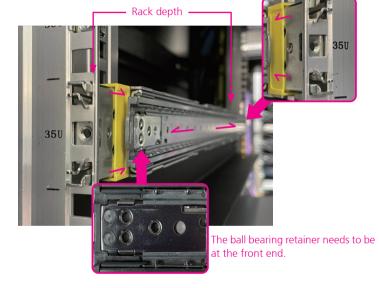


2. See the image below for inner vs. outer rails differences.



- 3. Install the left outer rail: Extend the left rail to match the rack depth, push the yellow safety clips at the front and rear ends inwards, align the tabs with the rack square holes, and insert it.
- 4. Push the yellow safety clips at the front and rear ends outward until they lock in place.

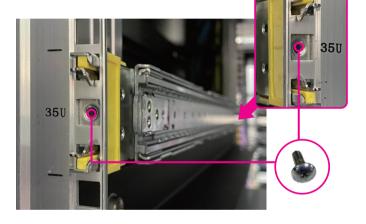




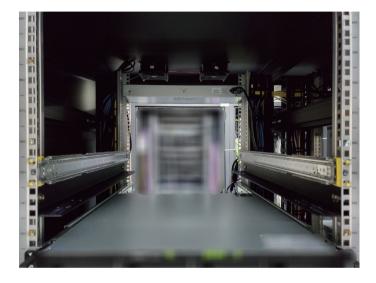




5. Secure the outer rail at the front and rear with M5*18mm screws. Once you have completed securing the left outer rail, repeat the same procedure to lock the right outer rail.



6. The outer rail installation is complete.

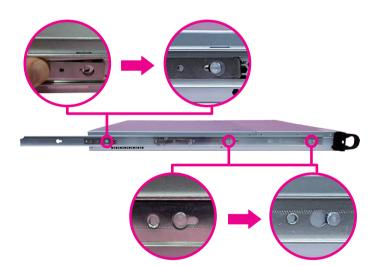






Inner Sliding Rail Installation and Detachment

1. Install the inner sliding rail by aligning it with the three flush rivets on the system and inserting it through the mounting holes. Before aligning the flush rivet at the rear side of the system, use your finger to press the spring clip on the inner rail, as demonstrated below (left top circle), to release the latch and engage the rear flush rivet. Pull the rail backward until it clicks into place in the smaller holes.



2. Tighten the inner sliding rail using M4*11mm screws, then repeat the same step to install the inner sliding rail on the other side.





3. The inner sliding rail installation is completed.

To remove the installed inner rail from system, push the spring clip outward (1) and then pull it inward (2) to detach it.







System Installation on Rack

1. Pull out the installed outer rail from the server rack



2. Align the system with both the installed inner rail and the outer rail within the server rack on both sides, then insert the system into the outer rail.





3. Toggle the latches on both sides of the outer rails.

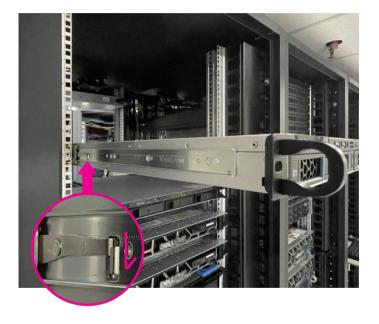


4. Insert the system into the rack until it can no longer be pushed in.





5. Press the latches on both sides of the inner rails, then push the system that was not completely inserted into the rack in the previous step until it is fully inserted.







6. The system installation on rack is completed.

